

Maintenance and Service Guide

HP Compaq nc8000 Business Notebook HP Compaq nw8000 Mobile Workstation

Document Part Number: 333954-005

October 2006

This guide is a troubleshooting reference used for maintaining and servicing the notebook. It provides comprehensive information on identifying notebook features, components, and spare parts; troubleshooting notebook problems; and performing notebook disassembly procedures.

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Maintenance and Service Guide HP Compaq nc8000 Business Notebook HP Compaq nw8000 Mobile Workstation

Fifth Edition: October 2006 First Edition: September 2003

Document Part Number: 333954-005

Contents

1	Product Description
	1.1 Models 1–2
	1.2 Features
	1.3 Clearing a Password
	1.4 Power Management
	1.5 External Components
	1.6 Design Overview
2	Troubleshooting
	2.1 Computer Setup and Diagnostics Utilities 2–2
	2.2 Using Diagnostics for Windows
	2.3 Troubleshooting Flowcharts

3	Illustrated Parts Catalog
	3.1 Serial Number Location 3–1
	3.2 Notebook Major Components
	3.3 Miscellaneous Plastics Kit Components
	3.4 Miscellaneous Cable Kit Components 3–10
	3.5 Mass Storage Devices
	3.6 Miscellaneous
	3.7 Sequential Part Number Listing 3–14
	3.7 Sequential Fait Number Listing 3–14
4	Removal and Replacement Preliminaries
4	Removal and Replacement Preliminaries
4	•
4	Removal and Replacement Preliminaries 4.1 Tools Required
4	Removal and Replacement Preliminaries 4.1 Tools Required
4	Removal and Replacement Preliminaries 4.1 Tools Required
4	Removal and Replacement Preliminaries 4.1 Tools Required

5 Removal and Replacement Procedures

5.1 Serial Number	5-2
5.2 Disassembly Sequence Chart	5–3
5.3 Preparing the Notebook for Disassembly	5–5
5.4 Notebook Feet 5	-11
5.5 MultiBay Device 5	-12
5.6 Bluetooth Board 5	-13
5.7 Integrated Smart Card 5	-15
5.8 Optical Drive 5	-17
5.9 Keyboard 5	-18
5.10 Memory Expansion Board 5	-22
5.11 Modem Board 5	-23
5.12 Mini PCI Communications Board 5	-24
5.13 Heat Sink 5	-27
5.14 Processor 5	-29
5.15 LED Switch Cover 5	-31
5.16 RTC Battery 5	-33
5.17 Security Module (TPM) 5	-34
5.18 Display Assembly 5	-35
5.19 Top Cover	-38
5.20 Speaker	-41
5.21 TouchPad 5	-42
5.22 Fan Assembly 5	-44
5.23 System Board	-46

- **6 Specifications**
- **A Connector Pin Assignments**
- **B** Power Cord Requirements
- **C** Screw Listing

Index

Product Description

The HP Compaq nc8000 Business Notebook and HP Compaq nw8000 Mobile Workstation offer advanced modularity, an Intel® Pentium® M processor with 64-bit architecture, an ATI MOBILITY RADEON 9600 Pro graphics controller with 128 or 64 MB of discrete video memory, and extensive multimedia support.



HP Compaq nc8000 Business Notebook and HP Compaq nw8000 Mobile Workstation

1.1 Models

Notebook model information is shown in Tables 1-1 through 1-3. Configuration code **LY2Z** applies to all models of the HP Compaq nc8000 Business Notebook. Configuration code **MDBZ** applies to all models of the HP Compaq nw8000 Mobile Workstation.

Table 1-1
HP Compaq nc8000 Business Notebook
and HP Compaq nw8000 Mobile Workstation
Model Naming Conventions

	Key													
Cn	Cnc P 170 U5				80	Υ	Gg	Р	XXXXXX-XXX					
1	1 2 3 4 5				5	6	7	8	9	10				
Key		Desc	cription	1		Options								
1		nd/Se ignato			C =	HP C	ompaq			nc8000 nw8000				
2	Pro	cesso	r type		P =	Intel F	Pentium	М						
3	Pro	cesso	r spee	d			0 GHz 0 GHz		150 = 1.50 GHz 140 = 1.40 GHz					
4		play ty e/reso	•		S = 3	UXGA SXGA XGA	-		5 = 15.X-inch					
5	Har	d driv	e size			80 G 60 G			40 = 40 GB					
6	Optical drive designator						ROM ·RW/R & W Com		W = DVD/CD-RW Combo Drive					

Table 1-1 HP Compaq nc8000 Business Notebook and HP Compaq nw8000 Mobile Workstation Model Naming Conventions (Continued)

								•		-	
						Key					
Cn	С	Р	170	U5	80	Υ	Gg	10	Р	XXXXXX-XXX	
1		2	3	4	5	6	7	8	9	10	
Key	I	Desc	cription	า				Opt	ions		
7		muni	d cation/ device			G = Combination modem + GB NIC					
8	RAM	1			10 = 1.0-GB 25 = 256-MB						
9	Operating system						soft® W soft Wir			Professional	
10	SKU	#									

Table 1-2 HP Compaq nc8000 Business Notebook Models

These HP Compaq nc8000 Business Notebook models feature the following:

- Dual point (pointing stick and TouchPad) pointing device
- 128-MB discrete video memory
- 8-cell, lithium ion (Li-lon) battery pack
- 3-year warranty on parts and labor

Cnc8000	Р	170	U5	60	Υ	Gm	51	Р	
Asia Pacifi Belgium Denmark France Germany Greece Italy	С		DQ6 DQ6 DQ6 DQ6	17A U 17A U 17A AI 17A AI 17A AI 17A AI	UG BY BF BD B7	Japan The Netherlands Norway Portugal Sweden/Finland United Kingdom United States			DQ617A ABJ DQ617A ABH DQ617A ABN DQ617A AB9 DQ617A AK8 DQ617A ABU DQ617A ABA
Cnc8000	Р	160	S5	40	D	Gm	51	Р	
Germany Italy Japan			DQ618A ABD DQ618A ABZ DQ618A ABJ			United Kingdom United States			DQ618A ABU DQ618A ABA

Table 1-2 HP Compaq nc8000 Business Notebook Models (Continued)

These HP Compaq Business Notebook nc8000 models feature the following:

- Dual point (pointing stick and TouchPad) pointing device
- 64-MB discrete video memory
- 8-cell, Li-Ion battery pack
- 3-year warranty on parts and labor

Cnc8000	Р	170	X5	60	W	Gm	51	Р	
French Car	nada		DH9	18U AI	ВС	United	State	s	DH918U ABA
Cnc8000	Р	160	S5	40	W	Gj	51	2	
Belgium Denmark Europe France Germany Greece			DJ24 DJ24 DJ24 DJ24	2A UU 2A AE 2A AE 2A AE 2A AE	BY BB BF BD	The N Norwa Portug Spain Swede Switze	ay gal en/Finl		DJ242A ABH DJ242A ABN DJ242A AB9 DJ242A ABE DJ242A AK8 DJ242A UUZ
Iceland Italy			DJ24	2A A2 2A AE	M	• • • • • • • • • • • • • • • • • • • •	d Kingo	dom	DJ242A ABU

Table 1-2
HP Compaq nc8000 Business Notebook Models (Continued)

Cnc8000 P	160	S5	40	D	Gn	51	Р	
Asia Pacific Australia Belgium Brazil Czech Republic Denmark Europe France French Canada Germany Greece Hong Kong Hungary Iceland India Israel Italy Japan Japan English Korea		DN88 DN88 DN88 DN88 DN88 DN88 DN88 DN88	 B9A UI B9A AE B9A AE	BBG C4 KB BBF BBC BBC BBC BBC BBC BBC BBC BBC BB	The N Norwa People Rep of C Polane Portuç Russia Saudi Slover Spain Swede Switze Taiwa Thaila Turkey United	e's bublic china d gal a Arabia nia en/Finl erland n	ands and and	DN889A ABM DN889A ABH DN889A ABN DN889A AB2 DN889A AKD DN889A AKD DN889A ACB DN889A ACB DN889A AKN DN889A AKN DN889A ABE DN889A AKB DN889A AKB DN889A AKB DN889A ABO DN889A ABO DN889A ABU DN889A ABB

Table 1-2
HP Compaq nc8000 Business Notebook Models (Continued)

Cnc8000	Р	160	S5	40	D	Gn	51	2	
Asia Pacifi Australia Belgium Brazil Czech Rep Denmark Europe France French Ca Germany Greece Hong Kong Hungary Iceland India Israel Italy Japan Japan Eng Korea	public nada		DN89 DN89 DN89 DN89 DN89 DN89 DN89 DN89	90A UU 90A AU 90A AU	BG GC4 KB BBSF BBF BBC BBD CJ BBC BBD CJ BBC BBC BBC BBC BBC BBC BBC BBC BBC		etherla ly e's lublic china d gal a Arabia nia en/Finl erland n nd /	ands a and	DN890A ABM DN890A ABH DN890A ABN DN890A AB2 DN890A AKD DN890A AB9 DN890A ACB DN890A ACB DN890A AKN DN890A ABE DN890A AKB DN890A AKB DN890A ABC
Cnc8000	Р	160	S5	40	W	Gj	51	Р	
Belgium Denmark Europe France Germany Greece Iceland Italy			DJ241A UUG DJ241A ABY DJ241A ABB DJ241A ABF DJ241A ABD DJ241A AB7 DJ241A A2M DJ241A ABZ			The Netherlands Norway Portugal Spain Sweden/Finland Switzerland United Kingdom			DJ241A ABH DJ241A ABN DJ241A AB9 DJ241A ABE DJ241A AK8 DJ241A UUZ DJ241A ABU

Table 1-2
HP Compaq nc8000 Business Notebook Models (Continued)

Cnc8000	RP	150	U5	60	W	Gj	51	Р	
Europe			DU2	50S#A	BB				
Cnc8000	RP	150	X5	40	D	Gi	25	Р	
People's R of China		;	DT8		I	I			
Cnc8000	RP	150	X5	40	D	Gp	25	2	
Belgium Czech Rep Denmark Europe France Germany Greece Hungary Iceland Israel Italy The Nethe			DJ244A#UUG DJ244A#AKB DJ244A#ABY DJ244A#ABB DJ244A#ABD DJ244A#ABD DJ244A#AKC DJ244A#AKC DJ244A#AZM DJ244A#ABT DJ244A#ABZ DJ244A#ABZ				ay d gal a Arabia nia en/Finl erland / d Kingo	and	DJ244A#ABN DJ244A#AKD DJ244A#ACB DJ244A#ABV DJ244A#AKN DJ244A#ABE DJ244A#AK8 DJ244A#UUZ DJ244A#AB8 DJ244A#ABU
Cnc8000	RP	150	X5	40	D	Gp	25	Р	
Denmark Europe France Germany Greece Hungary Iceland Israel Italy	Belgium DJ243A#UUG Dzech Republic DJ243A#AKB Denmark DJ243A#ABY Europe DJ243A#ABB France DJ243A#ABF Germany DJ243A#ABD Greece DJ243A#AB7 Hungary DJ243A#AKC DJ243A#AZM DJ243A#ABT					Norway Poland Portugal Russia Saudi Arabia Slovenia Spain Sweden/Finland Switzerland Turkey United Kingdom			DJ243A#ABN DJ243A#AKD DJ243A#ACB DJ243A#ABV DJ243A#AKN DJ243A#ABE DJ243A#AK8 DJ243A#UUZ DJ243A#AB8 DJ243A#AB8

Table 1-2 HP Compaq nc8000 Business Notebook Models (Continued)											
Cnc8000	RP	150	X5	40	W	Gi	25	Р			
	People's Republic DT819P#AB2 of China							!			
Cnc8000	RP	150	X5	60	W	Gb	25	Р			
Taiwan			DT8	15P#A	B0						
Cnc8000	RP	150	Y5	40	D	Gb	25	Р			
People's R of China		0	DS8	14P#A	B2						
Cnc8000	RP	150	Y5	40	W	Gi	51	Р			
People's R of China			DT8	I7P#A	B2						
Cnc8000	RP	150	Y5	60	W	Gi	51	Р			
United Sta	tes		DH9	36U#A	ВА	Frencl	n Cana	ada	DH936U#ABC		
Cnc8000	RP	150	Y5	60	W	GN	51	Н			
Europe		I	DU2	56S#A	BB						
Cnc8000	RP	150	Y5	60	W	Gb	51	Р			
Korea			DT80	7P#A	B1						
Cnc8000	Р	140	X5	40	D	Gi	25	Р			
Asia Pacific DQ616A UUF Belgium DQ616A UUG Denmark DQ616A ABY France DQ616A ABF Germany DQ616A ABD Greece DQ616A AB7 Italy DQ616A ABZ Japan DQ616A ABJ						The Netherlands Norway Portugal Spain Sweden/Finland Switzerland United Kingdom United States			DQ616A ABH DQ616A ABN DQ616A AB9 DQ616A ABE DQ616A AK8 DQ616A UUZ DQ616A ABU DQ616A ABA		
Cnc8000	Р	140	X5	40	D	Gn	25	Р			
French Ca	nada		DH9	17U AI	вс	United	d State	s	DH917U ABA		

Table 1-3 HP Compaq nw8000 Mobile Workstation Models

These HP Compaq nw8000 Mobile Workstation models feature the following:

- Dual point (pointing stick and TouchPad) pointing device
- 128-MB discrete video memory
- TPM security card
- 8-cell, Li-Ion battery pack
- 3-year warranty on parts and labor

Cnw8000	Р	170	U5	60	Υ	Gd	10	Р	
Asia Pacific Australia Hong Kong		•	DU536P UUF DU536P ABG DU536P AB5		1			DU536P AB2	
Japan Korea				36P AE 36P AE		Taiwa	n		DU536P AB0
Cnw8000	Р	170	U5	60	W	Gk	10	Р	
United Stat	es		DQ8	57A AI	ЗА				
Cnw8000	Р	160	X5	60	W	Gp	51	Р	
Australia DS864P ABG									
Cnw8000	Р	160	X5	60	W	Gp	51	2	
Australia DS865P ABG									

Table 1-3 HP Compaq nw8000 Mobile Workstation Models (Continued)

These HP Compaq nw8000 Mobile Workstation models feature the following:

- Dual point (pointing stick and TouchPad) pointing device
- 128-MB discrete video memory
- 8-cell, Li-Ion battery pack
- 3-year warranty on parts and labor

Cnw8000	Р	170	U5	60	Υ	Gd	10	Р	
Australia Hong Kong Japan Korea			DU535P ABG DU535P AB5 DU535P ABJ DU535P AB1				ublic hina		DU535P AB2 DU535P AB0
Cnw8000	Р	170	U5	60	Υ	Gn	51	Р	
Asia Pacific Australia Belgium Europe France French Car Germany Italy Japan Korea Hong Kong	nada		DN912A UUF DN912A ABG DN912A ABB DN912A ABF DN912A ABC DN912A ABC DN912A ABD DN912A ABZ DN912A ABJ DN912A AB1 DN912A AB1			Latin America People's Republic of China Spain Sweden/Finland Switzerland Taiwan United Kingdom United States		and	DN912A ABM DN912A AB2 DN912A ABE DN912A AK8 DN912A UUZ DN912A AB0 DN912A ABU DN912A ABA
Cnw8000	Р	170	U5	60	Υ	Gn	51	2	
Asia Pacific Australia Belgium Europe France French Car Germany Italy Japan Korea Hong Kong	nada		DN913A UUF DN913A ABG DN913A ABB DN913A ABF DN913A ABC DN913A ABC DN913A ABD DN913A ABJ DN913A ABJ DN913A ABJ		Latin America People's Republic of China Spain Sweden/Finland Switzerland Taiwan United Kingdom United States		and	DN913A ABM DN913A ABE DN913A AK8 DN913A UUZ DN913A AB0 DN913A ABU DN913A ABA	

Table 1-3 HP Compaq nw8000 Mobile Workstation Models (Continued)							(Continued)		
Cnw8000	Р	170	U5	60	W	Gm	51	Р	
Asia Pacific	Asia Pacific DU534P UUF						l	1	
Cnw8000	Р	170	U5	60	W	Gd	10	Р	
Asia Pacific	;		DU5	35P U	UF	Japan	l		DU529P ABJ
Cnw8000	Р	170	U5	60	W	Gd	10	2	
Japan			DU5	30P AI	3J			'	
Cnw8000	Р	170	U5	60	W	Gd	51	Р	
Japan			DU5	31P AI	3J		•		
Cnw8000	Р	170	S5	60	W	Gk	51	Р	
Europe France Germany Italy			DQ556A ABB DQ556A ABF DQ556A ABD DQ556A ABZ		Japan United Kingdom United States			DQ556A ABJ DQ556A ABU DQ556A ABA	
Cnw8000	Р	170	X5	60	W	Gm	51	Р	
Asia Pacific	;		DU5	32P U	UF		•		
Cnw8000	Р	160	X5	60	W	Gi	51	Р	
People's Re of China	epublio	0	DT82	21P AE	32				
Cnw8000	Р	150	X5	60	W	Gm	51	Р	
Asia Pacific	;		DU5	33P U	UF				
Cnw8000	Р	150	X5	60	W	Gi	51	Р	
People's Republic DT820P AB2 of China			32						
Cnw8000	Р	170	U5	60	W	Gm	10	Р	
French Car	nada	•	DH9	19U AI	ВС	United	d State	S	DH919U ABA

Table 1-3	
HP Compaq nw8000 Mobile Workstation Models	(Continued)

Cnw8000	Р	170	U5	60	W	Gg	51	Р	
Belgium Europe France Germany Italy			DJ29 DJ29 DJ29)4A UU)4A AE)4A AE)4A AE	BB BF BD	Spain Swede Switze United	erland	dom	DJ294A ABE DJ294A AK8 DJ294A UUZ DJ294A ABU
Cnw8000	Р	160	S5	40	W	Gn	51	Р	
French Car	ch Canada DH920U ABC			United	State	s	DH920U ABA		

1.2 Features

- Intel Pentium M 1.7-, 1.6-, 1.5-, and 1.4-GHz processors, all with 1024-KB L2 cache and 400-MHz processor side bus, varying by notebook model
- 15.1-inch UXGA (1600×1200), SXGA+ (1400×1050), or XGA (1024×768) TFT display with over 16.7 million colors, varying by notebook model
- ATI MOBILITY RADEON 9600 Pro graphics controller with 128 or 64 MB of video memory, varying by notebook model
- 80-, 60-, or 40-GB high-capacity hard drive, varying by notebook model
- 256-MB DDR Synchronous DRAM (SDRAM) at 333 MHz, expandable to 2.0 GB
- Microsoft® Windows® 2000 or Windows XP Professional, varying by notebook model
- Full-size Windows 98 keyboard with integrated numeric keypad
- Dual point (TouchPad and pointing stick) pointing device, with TouchPad on/off button and light

- Integrated Secure Digital (SD) Memory Card flash media slot
- Integrated 10/100/1000 BASE-T Ethernet local area network (LAN) NIC with RJ-45 connector
- Integrated wireless support for Bluetooth® LAN and Mini PCI 802.11a/b/g LAN devices
- Support for fixed optical drive and MultiBay device
- Support for two Type II/Type III PC Card slots (one integrated) with support for both 32-bit (CardBus) and 16-bit PC Cards
- External 65-W AC adapter with power cord
- 8-cell Li-Ion battery pack
- HP PremierSound audio
- Support for the following optical drives:
 - ☐ 24X Max DVD/CD-RW Combo Drive
 - □ 24X Max DVD+RW/R and CD-RW Combo Drive
 - □ 8X Max DVD-ROM Drive
 - □ 24X Max CD-ROM Drive

Co	nnectors:
	SD Card
	Infrared
	Two Type II PC Card slots
	RJ-11 (modem)
	RJ-45 (NIC)
	Two Universal Serial Bus (USB) 2.0
	S-Video
	Parallel
	Serial
	External monitor
	DC power
	Docking
	IEEE 1394 digital
	Microphone
	Stereo speaker/headphone

1.3 Clearing a Password

If the notebook you are servicing has an unknown password, follow these steps to clear the password. These steps also clear the CMOS memory:

- Prepare the notebook for disassembly (refer to Section "5.3 Preparing the Notebook for Disassembly" for more information).
- 2. Remove the real time clock (RTC) battery (refer to Section "5.16 RTC Battery").
- 3. Wait approximately 5 minutes.
- 4. Replace the RTC battery and reassemble the notebook.
- 5. Connect AC power to the notebook. Do **not** reinsert any battery packs at this time.
- 6. Turn on the notebook.

All passwords and all CMOS settings are cleared.

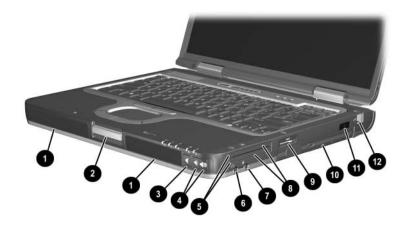
1.4 Power Management

The notebook comes with power management features that extend battery operating time and conserve power. The notebook supports the following power management features:

- Standby
- Hibernation
- Setting customization by the user
- Hotkeys for setting the level of performance
- Lid switch standby/resume
- Power/standby button
- Advanced Configuration and Power Management (ACPM) compliance

1.5 External Components

The external components on the front and right side of the notebook are shown below and described in Table 1-4.

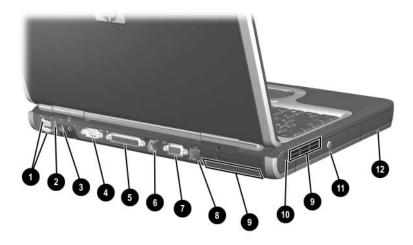


Front and Right-Side Components

Table 1-4 Front and Right-Side Components

Item	Component	Function
1	Stereo speakers (2)	Produce stereo sound.
2	Display release latch	Opens the notebook.
3	Mute button	Mutes the system volume. The button lights up when volume is muted.
4	Volume control buttons	Increase and decrease system volume. Press the volume up button (on right) to increase sound. Press the volume down button (on left) to decrease sound.
5	PC Card eject buttons	Eject an optional PC Card or smart card (if a smart card reader is installed) from the top or bottom PC Card slot.
6	Audio line-out jack	Connects optional powered stereo speakers, headphones, headset, or television audio.
7	Microphone jack	Connects an optional monaural microphone.
8	PC Card slots	Support optional Type I, Type II, or Type III 32-bit (CardBus) or 16-bit PC Cards.
		In select notebooks, one PC Card slot can be replaced with a factory-installed smart card reader.
9	Secure Digital (SD) slot	Accepts SD Memory Card and MultiMedia Cards.
10	MultiBay	Supports an optional MultiBay device, such as a drive or battery pack.
11	Infrared port	Provides wireless communication between the notebook and an optional IrDA-compliant device.
12	RJ-11 jack	Connects a modem cable.

The external components on the rear and left side are shown below and described in Table 1-5.



Rear and Left-Side Components

Table 1-5 Rear and Left-Side Components

Item	Component	Function
1	USB connectors (2)	Connect USB 1.1- and 2.0-compliant devices to the notebook using a standard USB cable.
		The bottom connector is a self-powered USB connector. It can be used to connect USB 1.1- and 2.0-compliant devices to the notebook using a standard USB cable, and connect an optional External MultiBay to the notebook using the External MultiBay-powered USB cable.
2	1394 connector	Connects a device that requires high bandwidth, such as a digital camera or other video or audio device.

Table 1-5 Rear and Left-Side Components (Continued)

Item	Component	Function
3	Power connector	Connects an AC adapter or an optional Automobile Power Adapter/Charger or Aircraft Power Adapter.
4	Serial connector	Connects an optional serial device.
5	Parallel connector	Connects an optional parallel device, such as an external diskette drive or a printer.
6	S-Video out jack	Connects an optional S-Video device, such as a television, VCR, camcorder, overhead projector, or video capture card.
7	External monitor connector	Connects an optional external monitor or overhead projector.
8	RJ-45 jack	Connects a network cable.
9	Intake vents (2)	Enable airflow to cool internal components. To prevent overheating, do not obstruct vents. Using the notebook on a soft surface, such as a pillow, blanket, rug, or thick clothing, can block airflow.
10	Security cable slot	Attaches an optional security cable to the notebook. The purpose of security solutions is to act as a deterrent. These solutions do not prevent the product from being mishandled or stolen.
11	Optical disk drive	Reads and records CD and DVD media.
12	Battery bay	Holds the primary battery pack. The battery pack ships outside the notebook.

The notebook keyboard components are shown below and described in Table 1-6.

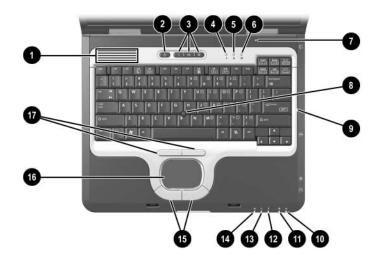


Keyboard Components

Table 1-6 Keyboard Components

Item	Component	Function
1	Windows logo key	Displays the Windows Start menu.
2	fn key	Executes frequently used system functions when pressed in combination with a function key or the esc key.
3	caps lock key	Enables capital alphabetic character lock.
4	f1 through f12 function keys	Execute indicated system functions when pressed in combination with the fn key.
5	num lock key	Enables numeric lock and the internal keypad.
6	Internal keypad	Can be used like the keys on an external numeric keypad.
7	Cursor control keys	Move the cursor around the screen.
8	Application key	Displays shortcut menu for items beneath the pointer.

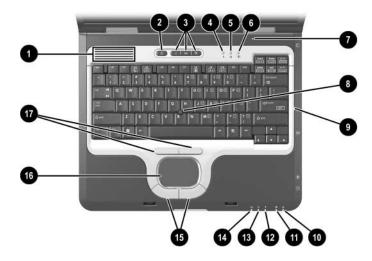
The notebook top components are shown below and described in Table 1-7.



Top Components

Table 1-7 Top Components

Item	Component	Function
1	Intake vents (2)	Enable airflow to cool internal components.
		To prevent overheating, do not obstruct vents. Using the notebook on a soft surface, such as a pillow, blanket, rug, or thick clothing, can block airflow.
2	Power button	When the notebook is:
		Off, press and release to turn on the notebook.
		In Standby, press and release to exit Standby.
		In Hibernation, press and release to exit Hibernation.
		If the system has stopped responding and Windows shutdown procedures cannot be used, press and hold for five seconds to turn off the notebook.
3	Quick Launch buttons (3)	Enable you to access common functions with a single keystroke.
4	Num lock light	On: Num lock is on or the embedded numeric keypad is enabled.
5	Caps lock light	On: Caps lock is on.
6	Scroll lock light	On: Scroll lock is on.
7	Display lid switch	If the notebook is closed while on, turns off the display.
		If the notebook is opened while in Standby, turns on the notebook (resumes from Standby).
8	Pointing stick	Moves the pointer and selects or activates items on the screen.
9	Microphone	Allows for audio input.

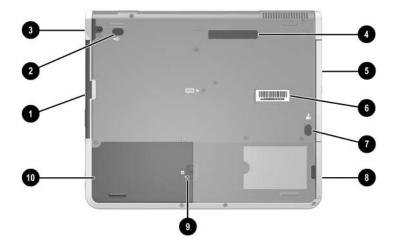


Top Components (Continued)

Table 1-7 Top Components (Continued)

Item	Component	Function
10	MultiBay light	On: A drive in the MultiBay is being accessed.
11	Drive light	On: One of the following integrated drives is being accessed:
		■ Hard drive
		■ Fixed optical drive
12	Battery light	On: A battery pack is charging. Blinking: A battery pack that is the only available power source has reached a low-battery condition. When the battery reaches a critical low-battery condition, the battery light begins blinking more quickly.
13	Power/Standby light	On: Power is turned on. Blinking: Notebook is in standby. The power/standby light also blinks when a battery pack that is the only available power source reaches a critical low-battery condition. The light turns off when the system enters hibernation or shuts down.
14	Wireless on/off light	On: An integrated wireless device has been enabled.
15	Left and right TouchPad buttons	Function like the left and right buttons on an external mouse.
16	TouchPad	Moves the pointer and selects or activates items on the screen. Can be set to perform other mouse functions, such as scrolling and double-clicking.
17	Left and right pointing stick buttons	Function like the left and right buttons on an external mouse.

The external components on the bottom of the notebook are shown below and described in Table 1-8.



Bottom Components

Table 1-8 Bottom Components

Item	Component	Function
1	MultiBay	Supports an optional MultiBay device, such as a drive or battery pack.
2	MultiBay release latch	Allows removal of the MultiBay drive.
3	Bluetooth compartment	Holds a Bluetooth device.
		Bluetooth is not available in all countries.
4	Docking connector	Connects the notebook to an optional port replicator.
5	Optical disk drive	Reads and records CD and DVD media.
6	Serial number	Identifies the notebook. You need this number when calling customer support.
7	Battery pack release latch	Releases the primary battery pack from the battery bay.
8	Battery bay	Holds the primary battery pack. Battery pack ships outside the notebook.
9	Hard drive cover latch	Releases the cover on the hard drive bay.
10	Hard drive	Holds the primary hard drive.

1.6 Design Overview

This section presents a design overview of key parts and features of the notebook. Refer to Chapter 3, "Illustrated Parts Catalog" to identify replacement parts, and Chapter 5, "Removal and Replacement Procedures" for disassembly steps.

The system board provides the following device connections:

- Memory expansion board
- Mini PCI communications devices
- Hard drive
- Display
- Keyboard, TouchPad, and pointing stick
- Audio
- Intel Pentium M processor
- Fan
- PC Card
- MCD modem
- Bluetooth wireless LAN



CAUTION: To properly ventilate the notebook, allow at least a 7.6-cm (3-inch) clearance on the left and right sides of the notebook.

The notebook uses an electrical fan for ventilation. The fan is controlled by a temperature sensor and is designed to turn on automatically when high temperature conditions exist. These conditions are affected by high external temperatures, system power consumption, power management/battery conservation configurations, battery fast charging, and software applications. Exhaust air is displaced through the ventilation grill located on the left side of the notebook.

Troubleshooting



WARNING: Only authorized technicians trained by HP should repair this equipment. All troubleshooting and repair procedures are detailed to allow only subassembly/module-level repair. Because of the complexity of the individual boards and subassemblies, do not attempt to make repairs at the component level or modifications to any printed wiring board. Improper repairs can create a safety hazard. Any indication of component replacement or printed wiring board modification may void any warranty or exchange allowances.

2.1 Computer Setup and Diagnostics Utilities

The notebook features two system management utilities:

- Computer Setup—A system information and customization utility that can be used even when your operating system is not working or does not load. This utility includes settings that are not available in Microsoft Windows.
- **Diagnostics for Windows**—A system information and diagnostic utility that is used within the Windows operating system. Use this utility whenever possible to:
 - ☐ Display system information.
 - ☐ Test system components.
 - ☐ Troubleshoot a device configuration problem in Windows XP Professional or Windows XP Home.



It is not necessary to configure a device connected to a USB connector on the notebook or to an optional HP Port Replicator.

Using Computer Setup

Information and settings in Computer Setup are accessed from the File, Security, or Advanced menus:

- 1. Turn on or restart the notebook. Press **F10** while the F10 = ROM-Based Setup message is displayed in the lower left corner of the screen.
 - ☐ To change the language, press **F2**.
 - \Box To view navigation information, press F1.
 - ☐ To return to the Computer Setup menu, press esc.
- 2. Select the **File**, **Security**, or **Advanced** menu.

- 3. To close Computer Setup and restart the notebook:
 - ☐ Select **File > Save Changes** and Exit and press **enter**.
 - or -
 - □ Select **File > Ignore Changes** and Exit and press **enter**.
- 4. When you are prompted to confirm your action, press F10.

Selecting from the File Menu

	Table 2-1 File Menu	
Select	To Do This	
System Information	■ View identification information about the notebook, a Port Replicator, and any battery packs in the system.	
	View specification information about the processor, memory and cache size, and system ROM.	
Save to Floppy	Save system configuration settings to a diskette.	
Restore from Floppy	Restore system configuration settings from a diskette.	
Restore Defaults	Replace configuration settings in Computer Setup with factory default settings. Identification information is retained.	
Ignore Changes and Exit	Cancel changes entered during the current session, then exit and restart the notebook.	
Save Changes and Exit	Save changes entered during the current session, then exit and restart the notebook.	

Selecting from the Security Menu

Table 2-2 Security Menu			
Select	To Do This		
Setup Password	Enter, change, or delete a Setup password. The Setup password is called an administrator password in Computer Security, a program accessed from the Windows Control Panel.		
Power-on Password	Enter, change, or delete a power-on password.		
DriveLock Passwords	Enable/disable DriveLock; change a DriveLock User or Master password.		
	DriveLock Settings are accessible only when you enter Computer Setup by turning on (not restarting) the notebook.		
Password Options (Password options can be selected only when a power-on password has been set.) Device Security	Enable/disable: ■ QuickLock ■ QuickLock on Standby ■ QuickBlank To enable QuickLock on Standby or QuickBlank, you must first enable QuickLock. Enable/disable: ■ Ports or diskette drives* ■ Diskette write*		
System IDs	CD-ROM or diskette startup Settings for a DVD-ROM can be entered in the CD-ROM field. Enter identification numbers for the notebook, a Port Replicator, and all battery packs in the system.		
*Not applicable to SuperDisl	,		

Selecting from the Advanced Menu

Table 2-3 Advanced Menu			
Select To Do This			
Language	Change the Computer Setup language.		
Boot Options Enable/disable:			
	QuickBoot, which starts the notebook more quickly by eliminating some startup tests. If you suspect a memory failure and want to test memory automatically during startup, disable QuickBoot.		
	MultiBoot, which sets a startup sequence that can include most bootable devices and media in the system.		
Device Options	Enable/disable the embedded numeric keypad at startup.		
	Enable/disable multiple standard pointing devices at startup. To set the notebook to support only a single, usually nonstandard, pointing device at startup, select Disable .		
	■ Enable/disable USB legacy support for a USB keyboard. When USB legacy support is enabled, the keyboard works even when a Windows operating system is not loaded.		
	■ Set an optional external monitor or overhead projector connected to a video card in a Port Replicator as the primary device. When the notebook display is set as secondary, the notebook must be shut down before it is undocked from a Port Replicator.		

Table 2-3 Advanced Menu (Continued)

Select	To Do This
Device Options (continued)	Change the parallel port mode from Enhanced Parallel Port (EPP, the default setting) to standard, bidirectional EPP, or Enhanced Capabilities Port (ECP).
	Set video-out mode to NTSC (default), PAL, NTSC-J, or PAL-M.*
	Enable/disable all settings in the Intel SpeedStep window. When Disable is selected, the notebook runs in Battery Optimized mode.
	■ Specify how the notebook recognizes multiple identical Port Replicators that are identically equipped. Select Disable to recognize the Port Replicators as a single Port Replicator; select Enable to recognize the Port Replicators individually, by serial number.
	Enable/disable the reporting of the processor serial number by the processor to the software.
HDD Self Test Options	Run a quick comprehensive self test on hard drives in the system that support the test features.

*Video modes vary even within regions. However, NTSC is common in North America; PAL, in Europe, Africa, and the Middle East; NTSC-J, in Japan; and PAL-M, in Brazil. Other South and Central American regions can use NTSC, PAL, or PAL-M.

2.2 Using Diagnostics for Windows

When you access Diagnostics for Windows, a scan of all system components is displayed on the screen before the diagnostics window opens.

You can display more or less information from anywhere within Diagnostics for Windows by selecting Level on the menu bar.

Diagnostics for Windows is designed to test HP components. If HP components are tested, the results might be inconclusive.

Obtaining, Saving, or Printing Configuration Information

- 1. Access Diagnostics for Windows by selecting **Start** > **Settings** > **Control Panel** > **Diagnostics for Windows**.
- 2. Select **Categories**, then select a category from the drop-down list.
 - \Box To save the information, select **File > Save As**.
 - \Box To print the information, select **File > Print**.
- 3. To close Diagnostics for Windows, select **File > Exit**.

Obtaining, Saving, or Printing Diagnostic Test Information

- 1. Access Diagnostics for Windows by selecting **Start > Settings > Control Panel > Diagnostics for Windows**.
- 2. Select the **Test** tab.
- 3. In the scroll box, select the category or device you want to test.
- 4. Select a test type:
 - ☐ Quick Test—Runs a quick, general test on each device in a selected category.
 - ☐ Complete Test—Performs maximum testing on each device in a selected category.
 - ☐ Custom Test—Performs maximum testing on a selected device.
 - ◆ To run all tests for your selected device, select the Check All button.
 - ◆ To run only the tests you select, select the Uncheck All button, then select the check box for each test you want to run.

5. Select a test mode:

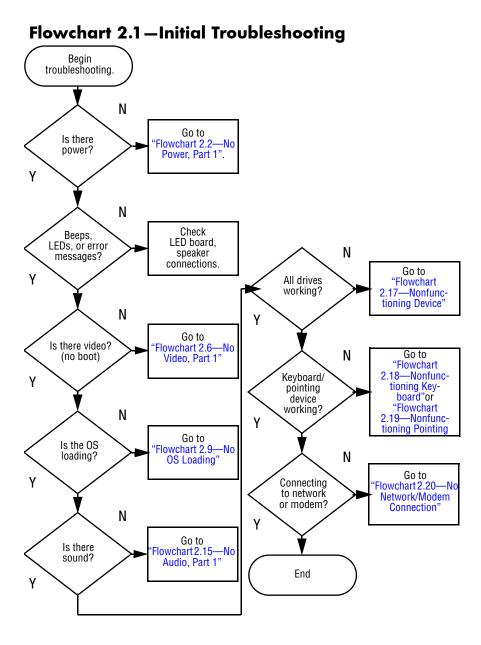
- ☐ Interactive Mode—Provides maximum control over the testing process. You determine whether the test was passed or failed. You might be prompted to insert or remove devices.
- ☐ Unattended Mode—Does not display prompts. If errors are found, they are displayed when testing is complete.

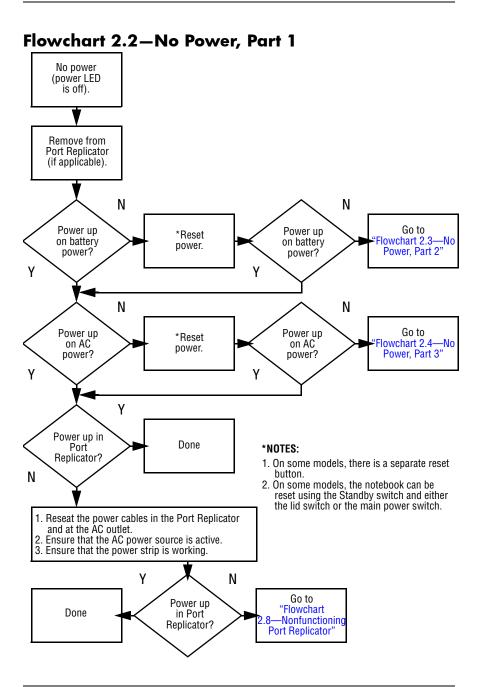
6.	Sel	ect the Begin Testing button.	
7. Select a tab to view a test report:			
		Status tab —Summarizes the tests run, passed, and failed during the current testing session.	
		Log tab —Lists tests run on the system, the number of times each test has run, the number of errors found on each test, and the total run time of each test.	
		Error tab —Lists all errors found in the notebook, along with the corresponding error codes.	
8.	Sel	ect a tab to save the report:	
		Log tab—Select the Save button.	
		Error tab—Select the Save button.	
9.	Sel	ect a tab to print the report:	
		Log tab —Select File > Save As, and then print the file from your folder.	

2.3 Troubleshooting Flowcharts

Table 2-4 Troubleshooting Flowcharts Overview

Flowchart	Description
2.1	"Flowchart 2.1—Initial Troubleshooting"
2.2	"Flowchart 2.2—No Power, Part 1"
2.3	"Flowchart 2.3—No Power, Part 2"
2.4	"Flowchart 2.4—No Power, Part 3"
2.5	"Flowchart 2.5—No Power, Part 4"
2.6	"Flowchart 2.6—No Video, Part 1"
2.7	"Flowchart 2.7—No Video, Part 2"
2.8	"Flowchart 2.8—Nonfunctioning Port Replicator"
2.9	"Flowchart 2.9—No OS Loading"
2.10	"Flowchart 2.10—No OS Loading, Hard Drive, Part 1"
2.11	"Flowchart 2.11—No OS Loading, Hard Drive, Part 2"
2.12	"Flowchart 2.12—No OS Loading, Hard Drive, Part 3"
2.13	"Flowchart 2.13—No OS Loading, Diskette Drive"
2.14	"Flowchart 2.14—No OS Loading, CD- or DVD-ROM Drive"
2.15	"Flowchart 2.15—No Audio, Part 1"
2.16	"Flowchart 2.16—No Audio, Part 2"
2.17	"Flowchart 2.17—Nonfunctioning Device"
2.18	"Flowchart 2.18—Nonfunctioning Keyboard"
2.19	"Flowchart 2.19—Nonfunctioning Pointing Device"
2.20	"Flowchart 2.20—No Network/Modem Connection"





Flowchart 2.3—No Power, Part 2 Continued from 'Flowchart 2.2—No Power, Part 1" Visually check for debris in battery socket and clean if necessary. Υ Power on? Done N Check battery by recharging it, moving it to another notebook, or replacing it. N

Replace power supply (if applicable).

Power on?

Done

N

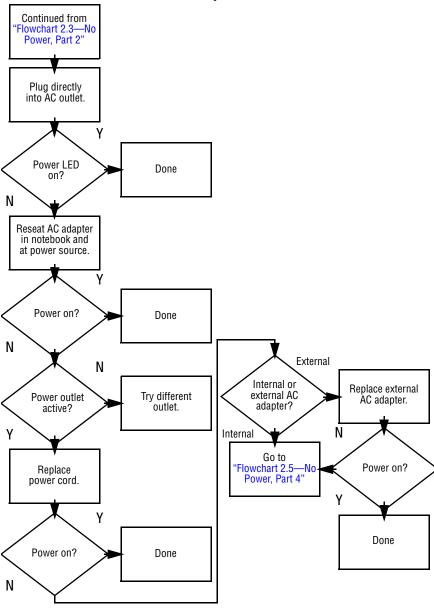
Go to Flowchart 2.4—No Power, Part 3"

Power on?

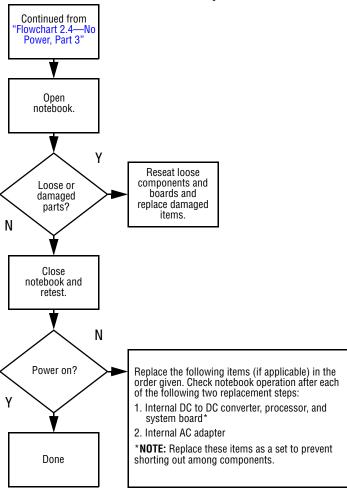
Done

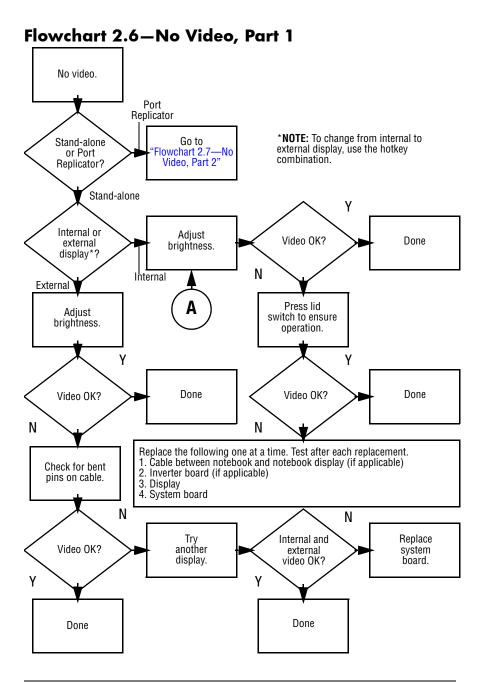
Υ

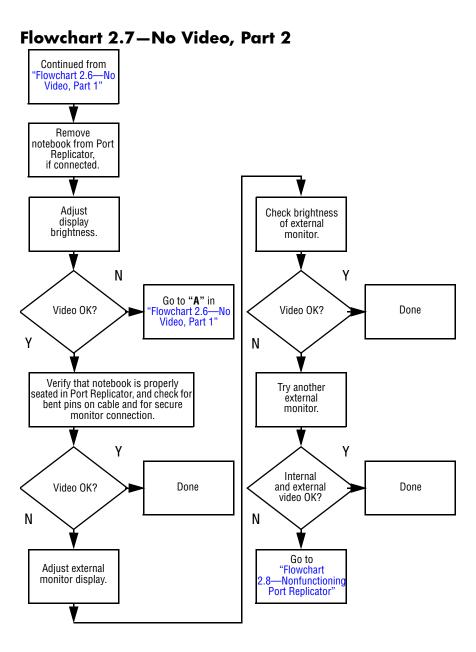
Flowchart 2.4—No Power, Part 3



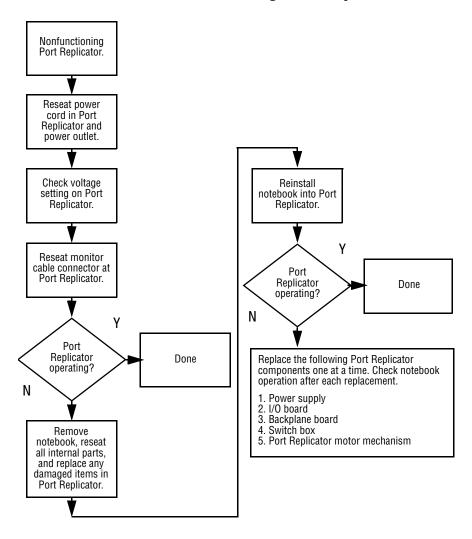
Flowchart 2.5—No Power, Part 4

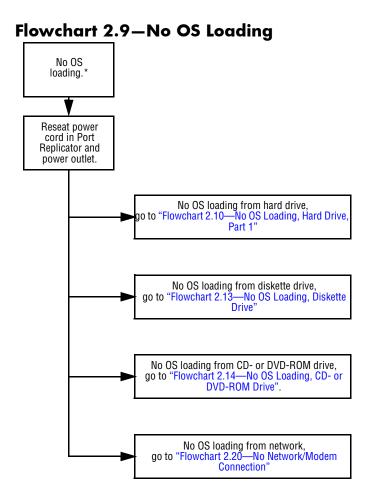






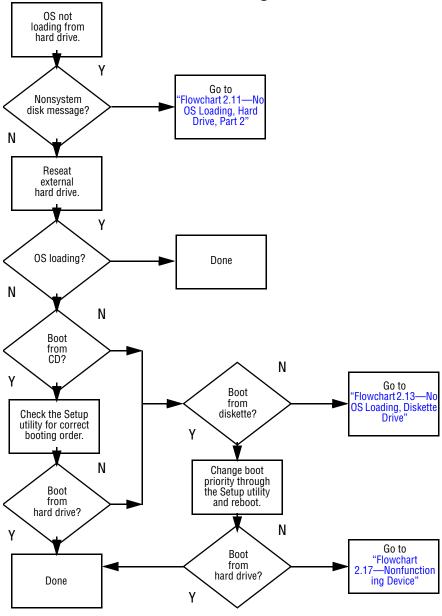
Flowchart 2.8—Nonfunctioning Port Replicator



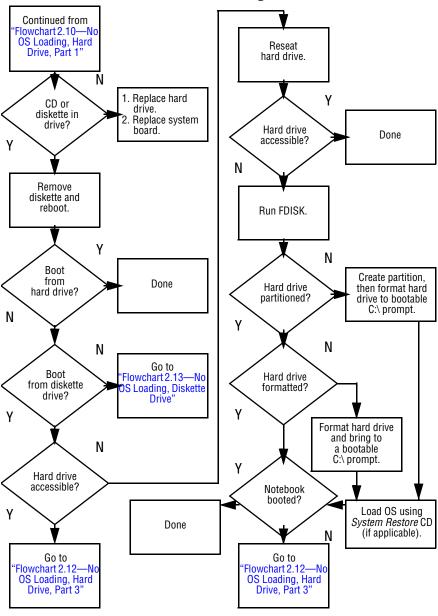


^{*}NOTE: Before beginning to troubleshoot, always check cable connections, cable ends, and drives for bent or damaged pins.

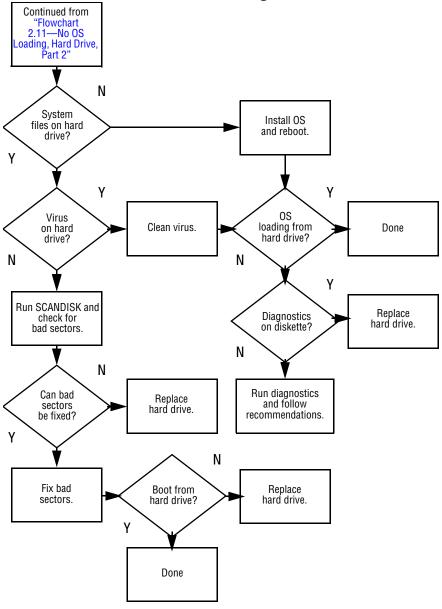
Flowchart 2.10—No OS Loading, Hard Drive, Part 1

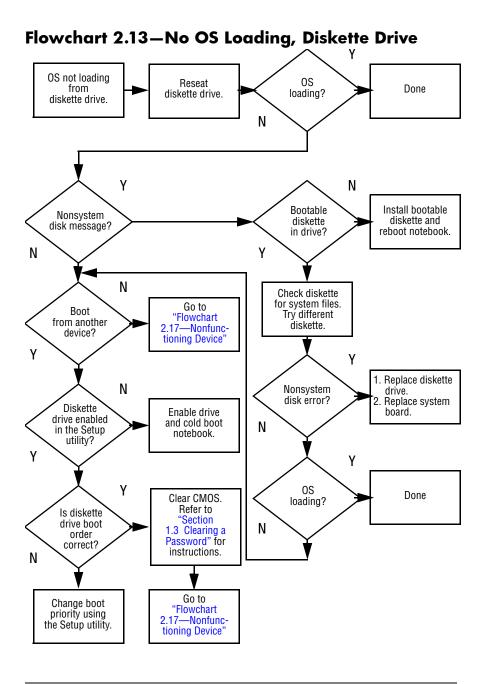


Flowchart 2.11—No OS Loading, Hard Drive, Part 2

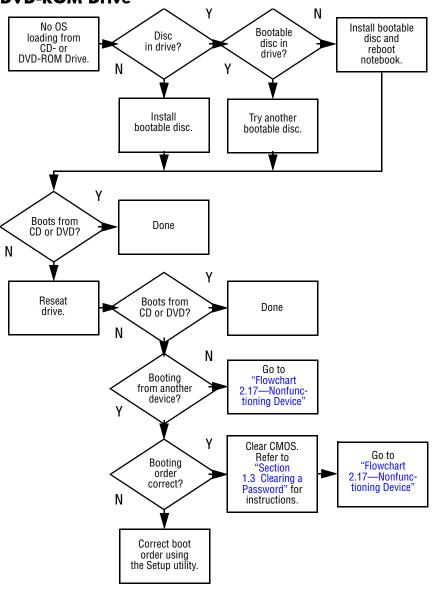


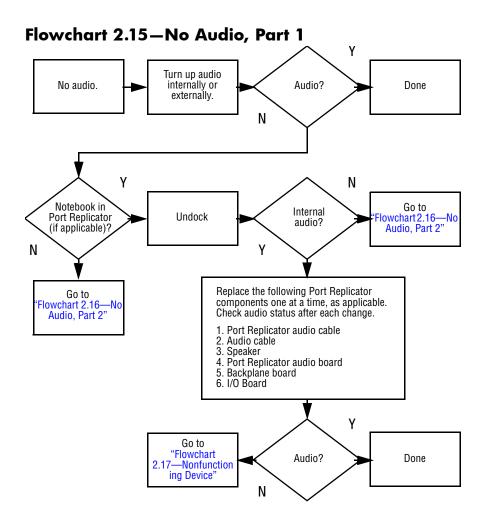
Flowchart 2.12—No OS Loading, Hard Drive, Part 3



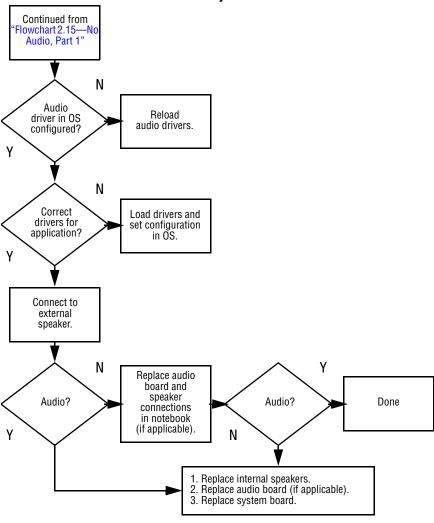


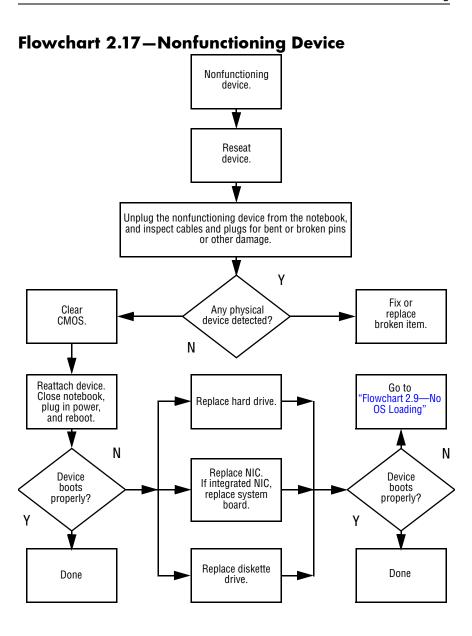
Flowchart 2.14—No OS Loading, CD- or DVD-ROM Drive



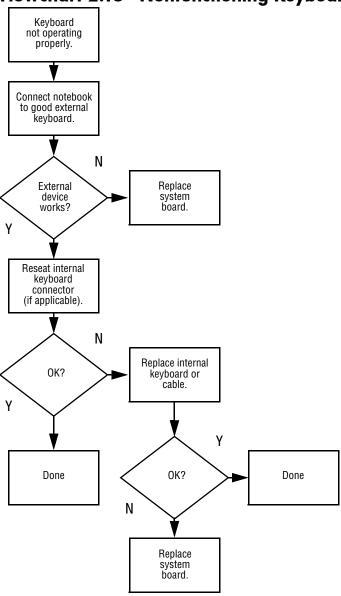


Flowchart 2.16—No Audio, Part 2

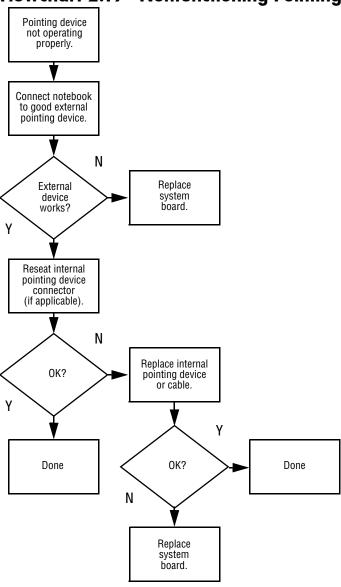




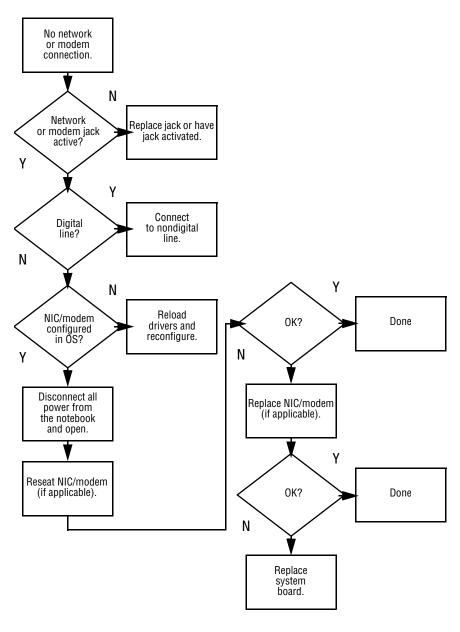
Flowchart 2.18—Nonfunctioning Keyboard



Flowchart 2.19—Nonfunctioning Pointing Device



Flowchart 2.20—No Network/Modem Connection

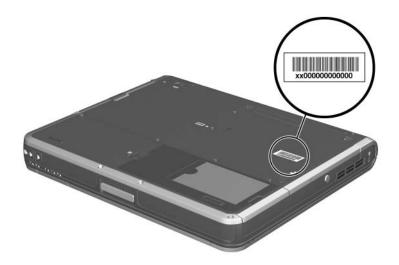


Illustrated Parts Catalog

This chapter provides an illustrated parts breakdown and a reference for spare part numbers and option part numbers.

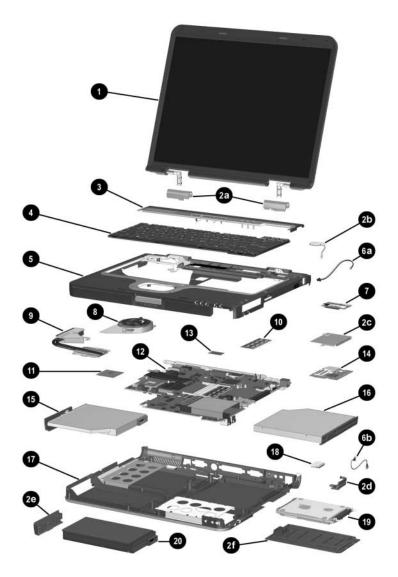
3.1 Serial Number Location

When ordering parts or requesting information, provide the notebook serial number and model number located on the bottom of the notebook.



Serial Number Location

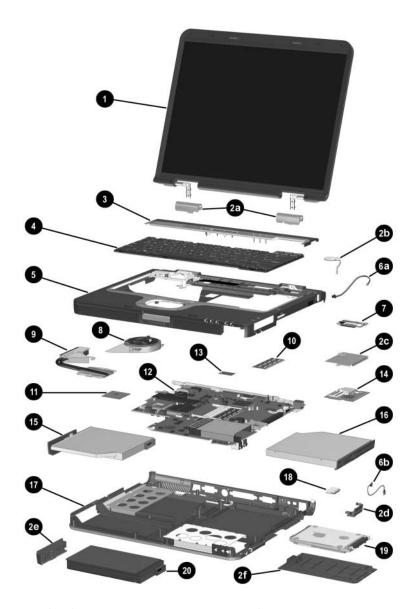
3.2 Notebook Major Components



Notebook Major Components

Table 3-1		
Spare Parts: Notebook Major Components		

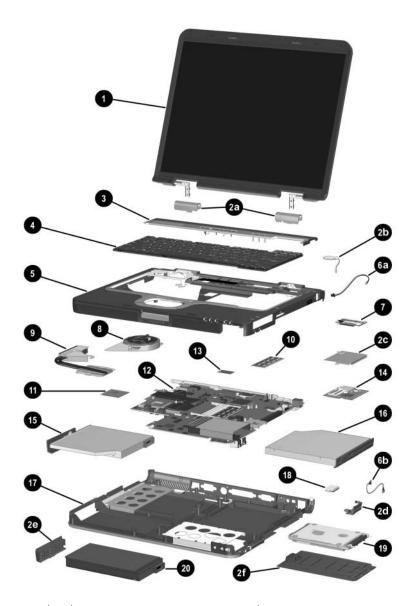
Item	Description			Spare Part Number
1	Display assemblies			
	15.0-inch, UXGA+, TFT 15.0-inch, SXGA+, TFT 15.0-inch, XGA, TFT			345060-001 345059-001 345058-001
	Miscellaneous	Plastics Kit, inc	ludes:	345066-001
2a 2b 2c 2d 2e 2f	Left and right display hinges RTC battery Mini PCI communications board shield Bluetooth cover Battery bezel Hard drive cover Not illustrated: Notebook feet (4)			
3	LED switch cover			345063-001
4	Keyboards (include pointing stick)			
	Brazil Czech Republic Denmark Europe France French Canada Germany Greece Greece - Blk Hungary Iceland International Israel Italy	341520-201 341520-221 341520-081 341520-051 341520-051 341520-121 341520-041 378539-151 373646-151 341520-211 341520-DD1 341520-B31 341520-BB1 341520-061	Japan Korea Latin America Norway Portugal Russia Saudi Arabia Slovenia Spain Sweden/Finland Switzerland Taiwan Thailand Turkey United Kingdom United States	341520-291 341520-AD1 341520-161 341520-091 341520-131 341520-251 341520-BA1 341520-BA1 341520-BG1 341520-BG1 341520-AB1 341520-281 341520-141 341520-031 341520-001
5	Top cover (inclu	ides TouchPad a	and speaker)	345061-001



Notebook Major Components (Continued)

Table 3-1
Spare Parts: Notebook Major Components (Continued)

Item	Description	Spare Part Number
	Miscellaneous Cable Kit, includes:	345056-001
6a 6b	Modem cable Bluetooth cable	
7	Modem board	325521-001
8	Fan assembly	345065-001
9	Heat sink (includes grease)	345067-001
10	Memory expansion boards, 333-MHz	
	1024-MB (1.0-GB) 512-MB 256-MB	336579-001 336578-001 336577-001
11	Processors (include thermal grease)	
	Intel Pentium M (Banias) processor, 1.7 GHz Intel Pentium M (Banias) processor, 1.6 GHz Intel Pentium M (Banias) processor, 1.5 GHz Intel Pentium M (Banias) processor, 1.4 GHz Intel Pentium M (Dothan) processor, 1.5 GHz Intel Pentium M (Dothan) processor, 1.6 GHz Intel Pentium M (Dothan) processor, 1.7 GHz Intel Pentium M (Dothan) processor, 1.8 GHz Intel Pentium M (Dothan) processor, 2.0 GHz	340165-001 319777-001 319776-001 319775-001 359636-001 356596-001 356597-001 345857-001 353395-001
12	System boards (include thermal grease)	
	With 128 MB of video memory With 64 MB of video memory	349206-001 345064-001
13	Trusted Platform Module (TPM)	345856-001
*	Integrated smart card	379336-001
*Not ill	ustrated.	



Notebook Major Components (Continued)

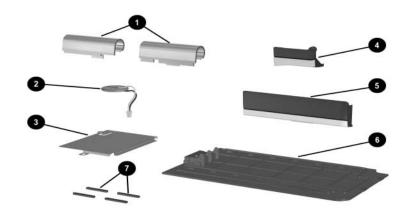
Table 3-1
Spare Parts: Notebook Major Components (Continued)

Item	Description			Spare Part Number
14	Mini PCI communications boards			
	802.11b wirele 802.11b wirele 802.11b/g wire	N NIC) MOW)	325525-001 325526-001 339742-291 345641-001 345640-001 368247-001 368248-001
15	Optical drives			
	8X Max DVD-	ROM Drive /CD-RW Comb	D-RW Combo Drive to Drive	349242-001 349241-001 349243-001 349240-001
16	MultiBay device	es		
		ROM Drive DVD+RW/R and	d CD-RW Combo Drive I CD-RW Combo Drive	241995-001 228746-001 251292-001 344256-001
17	Base enclosure (includes optical drive shield, hard drive shield, and four notebook feet) 345062-001			345062-001
18	Bluetooth board (includes Bluetooth cable, item 6b) 348277-001			348277-001
19	Hard drives (includes hard drive bezel and frame)			
	80-GB	5400-rpm	(all models)	345632-001
	60-GB	5400-rpm	(all models)	345631-001
	40-GB	5400-rpm	(all models)	345630-001
	60-GB	7200-rpm	(nw8000 only)	345855-001
20	Battery pack, 8-cell, 4.4 Wh, Li-lon 338669-001		338669-001	
*	Battery pack, 8	-cell, 4.8AHR		360663-001

Table 3-1
Spare Parts: Notebook Major Components

Item Description Spare Part Number

3.3 Miscellaneous Plastics Kit Components



Miscellaneous Plastics Kit Components

Table 3-2 Miscellaneous Plastics Kit Components Spare Part Number 345066-001

Item	Description
1	Left and right display hinges
2	RTC battery
3	Mini PCI communications board shield
4	Bluetooth cover
5	Battery bezel
6	Hard drive cover
7	Notebook feet (4)
*	Integrated smart card bezel
*Not ill	ustrated.

3.4 Miscellaneous Cable Kit Components

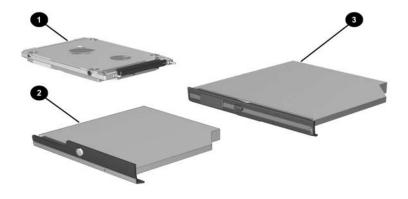


Miscellaneous Cable Kit Components

Table 3-3 Miscellaneous Cable Kit Components Spare Part Number 345056-001

Item	Description
1	Bluetooth cable
2	Modem cable

3.5 Mass Storage Devices



Mass Storage Devices

Table 3-4
Mass Storage Devices
Spare Part Number Information

Item	Description		Spare Part Number
1	Hard drives (includes hard	I drive bezel and frame)	_
	80-GB 5400-rpm	(all models)	345632-001
	60-GB 5400-rpm	(all models)	345631-001
	40-GB 5400-rpm	(all models)	345630-001
	60-GB 7200-rpm	(nw8000 only)	345855-001

Table 3-4 Mass Storage Devices Spare Part Number Information (Continued)

Item	Description	Spare Part Number
2	Optical drives	
	24X Max DVD+RW/R and CD-RW Combo Drive 8X Max DVD-ROM Drive 24X Max DVD/CD-RW Combo Drive 24X Max CD-ROM Drive	349242-001 349241-001 349243-001 349240-001
3	MultiBay devices	
	1.44-MB diskette drive24X Max CD-ROM Drive8X Max Slim DVD/R+W and CD-RW Combo Drive4X Max Regular DVD/R+W and CD-RW Combo Drive	135233-001 228746-001 251292-001 344256-001

3.6 Miscellaneous

Table 3-5 Spare Parts: Miscellaneous (not illustrated)

Description			Spare Part Number
AC adapters			
90-W, PFC 65-W			239705-001 239704-001
Carrying cases			
Leather top load, Leather top load, Nylon top load, Sa Nylon top load, So Nylon entry level	SG amsung		325817-001 325817-002 325815-001 325815-002 325814-001
Port replicators			
	Advanced Port Replicator Common Port Replicator		339096-001 339097-001
Power cords			
Australia Brazil Denmark Europe/Middle East/Africa Israel	246959-011 246959-201 246959-081 246959-021 246959-BB1	Italy Japan Korea Switzerland United Kingdom United States	246959-061 246959-291 246959-AD1 246959-AG1 246959-031 246959-001
	the following screw w Listing" for more ations and usage.)		345057-001
■ Torx T8M2.0×6.0 screw		■ Phillips PM3.0	×3.5 screw
■ Torx T8M2.0×4.0 screw		■ Phillips PM1.5	×4.0 screw
■ Torx T5M2.5×4.0 screw		■ Phillips PM1.5	×3.0 screw
■ Torx T8M2.0×3.5 screw		■ M2.0×10.0 alig	gnment pin

3.7 Sequential Part Number Listing

Table 3-6 Spare Parts: Sequential Part Number Listing

Spare Part Number	Description
228746-001	24X Max CD-ROM drive
239704-001	65-watt AC adapter
239705-001	90-watt, PFC, AC adapter
241995-001	Diskette drive
246959-001	3-wire power cord - United States
246959-011	3-wire power cord - Australia
246959-021	3-wire power cord - Europe, Middle East, Africa
246959-031	3-wire power cord - United Kingdom
246959-061	3-wire power cord - Italy
246959-081	3-wire power cord - Denmark
246959-201	3-wire power cord - Brazil
246959-291	3-wire power cord - Japan
246959-AD1	3-wire power cord - Korea
246959-AG1	3-wire power cord - Switzerland
246959-BB1	3-wire power cord - Israel
251292-001	8X Max Slim DVD+RW/R and CD-RW combo drive
319775-001	Intel Pentium M (Banias) processor, 1.4-GHz
319776-001	Intel Pentium M (Banias) processor, 1.5-GHz
319777-001	Intel Pentium M (Banias) processor, 1.6-GHz
325521-001	Modem board (includes cable)
325525-001	802.11a/b/g LAN board mini PCI communications board

Table 3-6
Spare Parts: Sequential Part Number Listing (Continued)

Spare Part Number	Description
325526-001	802.11b/g LAN board mini PCI communications board
325814-001	Nylon, entry level
325815-001	Nylon, top load, Samsung
325815-002	Nylon, top load, SG
325817-001	Leather, top load, Samsung
325817-002	Leather, top load, SG
336577-001	Memory expansion board, 333 MHz, 256-MB DDR
336578-001	Memory expansion board, 333 MHz, 512-MB DDR
336579-001	Memory expansion board, 333 MHz, 1024-MB DDR
338669-001	Battery pack, 8-cell, 4.4 Wh, Li-ion
339096-001	Advanced Port Replicator
339097-001	Simple Port Replicator
339742-291	802.11b W500 modem board (for use in Japan) mini PCI communications board
340165-001	Intel Pentium M (Banias) processor, 1.7-GHz
341520-001	Keyboard (including pointing stick) - United States
341520-031	Keyboard (including pointing stick) - United Kingdom
341520-041	Keyboard (including pointing stick) - Germany
341520-051	Keyboard (including pointing stick) - France
341520-061	Keyboard (including pointing stick) - Italy
341520-071	Keyboard (including pointing stick) - Spain
341520-081	Keyboard (including pointing stick) - Denmark
341520-091	Keyboard (including pointing stick) - Norway

Table 3-6
Spare Parts: Sequential Part Number Listing (Continued)

Spare Part Number	Description
341520-121	Keyboard (including pointing stick) - French Canada
341520-131	Keyboard (including pointing stick) - Portugal
341520-141	Keyboard (including pointing stick) - Turkey
341520-161	Keyboard (including pointing stick) - Latin America
341520-171	Keyboard (including pointing stick) - Saudi Arabia
341520-201	Keyboard (including pointing stick) - Brazil
341520-211	Keyboard (including pointing stick) - Hungary
341520-221	Keyboard (including pointing stick) - Czech Republic
341520-251	Keyboard (including pointing stick) - Russia
341520-281	Keyboard (including pointing stick) - Thailand
341520-291	Keyboard (including pointing stick) - Japan
341520-A41	Keyboard (including pointing stick) - European
341520-AB1	Keyboard (including pointing stick) - Taiwan
341520-AD1	Keyboard (including pointing stick) - Korea
341520-B31	Keyboard (including pointing stick) - International
341520-B71	Keyboard (including pointing stick) - Sweden/Finland
341520-BA1	Keyboard (including pointing stick) - Slovenia
341520-BB1	Keyboard (including pointing stick) - Israel
341520-BG1	Keyboard (including pointing stick) - Switzerland
341520-DD1	Keyboard (including pointing stick) - Iceland
344256-001	4X Max Reg DVD+RW/R and CD-RW combo drive
345056-001	Miscellaneous Cable Kit
345057-001	Misc Screw Kit

Table 3-6
Spare Parts: Sequential Part Number Listing (Continued)

Spare Part Number	Description
345058-001	Display assembly, 15.0-inch, XGA, TFT
345059-001	Display assembly, 15.0-inch, SXGA+, TFT
345060-001	Display assembly, 15.0-inch, UXGA+, TFT
345061-001	Top cover (includes TouchPad and speaker)
345062-001	Base enclosure (includes optical drive shield, hard drive shield, and four notebook feet)
345063-001	LED switch cover
345064-001	System board (includes 64-MB discrete video memory)
345065-001	Fan assembly
345066-001	Misc Plastics Kit
345067-001	Heat sink
345630-001	40-GB (5400-rpm) hard drive
345631-001	60-GB (5400-rpm) hard drive
345632-001	80-GB (5400-rpm) hard drive
345640-001	802.11b wireless LAN (ROW) Wireless LAN card
345641-001	802.11b wireless LAN (MOW) Wireless LAN card
345855-001	60-GB (7200-rpm) hard drive (nw8000 only)
345856-001	Trusted Platform Module (TPM)
345857-001	Intel Pentium M (Dothan) processor, 1.8 GHz
348277-001	Bluetooth wireless communications board
349206-001	System board (includes 128-MB discrete video memory)
349240-001	24X Max CD-ROM Drive
349241-001	8X Max DVD-ROM drive

Table 3-6
Spare Parts: Sequential Part Number Listing (Continued)

Spare Part Number	Description
349242-001	24X Max DVD+RW/R and CD-RW combo drive
349243-001	24X Max DVD/CD-RW combo drive
353395-001	Intel Pentium M (Dothan) processor, 2.0 GHz
356596-001	Intel Pentium M (Dothan) processor, 1.6 GHz
356597-001	Intel Pentium M (Dothan) processor, 1.7 GHz
359636-001	Intel Pentium M (Dothan) processor, 1.5 GHz
360663-001	Battery pack, 8-cell, 4.8AHR
365438-001	60-GB (7200-rpm) hard drive (includes bezel and frame)
368247-001	802.11b/g modem board (MOW) mini PCI communications board
368248-001	802.11b/g modem board (ROW) mini PCI communications board
373646-151	Keyboard (including pointing stick) - Greece Bk
378539-151	Keyboard (including pointing stick) - Greece
379336-001	Integrated smart card

Removal and Replacement Preliminaries

This chapter provides essential information for proper and safe removal and replacement service.

4.1 Tools Required

You need the following tools to complete the removal and replacement procedures:

- Magnetic screw driver
- Phillips P0 screw driver
- Torx8 screw driver
- Torx7 pin bit screw driver



Some computer models have two Torx7 with pin security screws (M2.0×4.0) securing the Mini PCI communications board to the computer. A T7 pin bit screw driver is required to remove the Mini PCI communications board on these computer models. Refer to Section 5.12, "Mini PCI Communications Board," for more information on removing Mini PCI communications boards.

- 5.0-mm socket for system board standoffs
- Flat-bladed screwdriver

4.2 Service Considerations

The following sections include some of the considerations that you should keep in mind during disassembly and assembly procedures.



As you remove each subassembly from the notebook, place the subassembly (and all accompanying screws) away from the work area to prevent damage.

Plastic Parts

Using excessive force during disassembly and reassembly can damage plastic parts. Use care when handling the plastic parts. Apply pressure only at the points designated in the maintenance instructions.

Cables and Connectors



CAUTION: When servicing the notebook, ensure that cables are placed in their proper locations during the reassembly process. Improper cable placement can damage the notebook.

Cables must be handled with extreme care to avoid damage. Apply only the tension required to unseat or seat the cables during removal and insertion. Handle cables by the connector whenever possible. In all cases, avoid bending, twisting, or tearing cables. Ensure that cables are routed in such a way that they cannot be caught or snagged by parts being removed or replaced. Handle flex cables with extreme care; these cables tear easily.

4.3 Preventing Damage to Removable Drives

Removable drives are fragile components that must be handled with care. To prevent damage to the notebook, damage to a removable drive, or loss of information, observe the following precautions:

- Before removing or inserting a hard drive, shut down the notebook. If you are unsure whether the notebook is off or in hibernation, turn the notebook on, then shut it down.
- Before removing a diskette drive or optical drive, ensure that a diskette or disc is not in the drive. Ensure that the optical drive tray is closed.
- Before handling a drive, ensure that you are discharged of static electricity. While handling a drive, avoid touching the connector.
- Handle drives on surfaces that have at least one inch of shock-proof foam.
- Avoid dropping drives from any height onto any surface.
- After removing a hard drive, an optical drive, or a diskette drive, place it in a static-proof bag.
- Avoid exposing a hard drive to products that have magnetic fields, such as monitors or speakers.
- Avoid exposing a drive to temperature extremes or liquids.
- If a drive must be mailed, place the drive in a bubble pack mailer or other suitable form of protective packaging and label the package "FRAGILE: Handle With Care."

4.4 Preventing Electrostatic Damage

Many electronic components are sensitive to electrostatic discharge (ESD). Circuitry design and structure determine the degree of sensitivity. Networks built into many integrated circuits provide some protection, but in many cases the discharge contains enough power to alter device parameters or melt silicon junctions.

A sudden discharge of static electricity from a finger or other conductor can destroy static-sensitive devices or microcircuitry. Often the spark is neither felt nor heard, but damage occurs.

An electronic device exposed to electrostatic discharge might not be affected at all and can work perfectly throughout a normal life cycle. Or the device might function normally for a while, then degrade in the internal layers, reducing its life expectancy.

4.5 Packaging and Transporting Precautions

Use the following grounding precautions when packaging and transporting equipment:

- To avoid hand contact, transport products in static-safe containers, such as tubes, bags, or boxes.
- Protect all electrostatic-sensitive parts and assemblies with conductive or approved containers or packaging.
- Keep electrostatic-sensitive parts in their containers until the parts arrive at static-free workstations.
- Place items on a grounded surface before removing them from their containers.
- Always be properly grounded when touching a sensitive component or assembly.
- Store reusable electrostatic-sensitive parts from assemblies in protective packaging or nonconductive foam.
- Use transporters and conveyors made of antistatic belts and roller bushings. Ensure that mechanized equipment used for moving materials is wired to ground and that proper materials are selected to avoid static charging. When grounding is not possible, use an ionizer to dissipate electric charges.

4.6 Workstation Precautions

Use the following grounding precautions at workstations:

- Cover the workstation with approved static-shielding material (refer to Table 4-2).
- Use a wrist strap connected to a properly grounded work surface and use properly grounded tools and equipment.
- Use conductive field service tools, such as cutters, screwdrivers, and vacuums.
- When using fixtures that must directly contact dissipative surfaces, use only fixtures made of static-safe materials.
- Keep the work area free of nonconductive materials, such as ordinary plastic assembly aids and Styrofoam.
- Handle electrostatic-sensitive components, parts, and assemblies by the case or PCM laminate. Handle these items only at static-free workstations.
- Avoid contact with pins, leads, or circuitry.
- Turn off power and input signals before inserting or removing connectors or test equipment.

4.7 Grounding Equipment and Methods

Grounding equipment must include either a wrist strap or a foot strap at a grounded workstation.

- When seated, wear a wrist strap connected to a grounded system. Wrist straps are flexible straps with a minimum of one megohm ±10% resistance in the ground cords. To provide proper ground, wear a strap snugly against the skin at all times. On grounded mats with banana-plug connectors, connect a wrist strap with alligator clips.
- When standing, use foot straps and a grounded floor mat. Foot straps (heel, toe, or boot straps) can be used at standing workstations and are compatible with most types of shoes or boots. On conductive floors or dissipative floor mats, use foot straps on both feet with a minimum of one-megohm resistance between the operator and ground. To be effective, the conductive strips must be worn in contact with the skin.

Other grounding equipment recommended for use in preventing electrostatic damage includes

- Antistatic tape.
- Antistatic smocks, aprons, and sleeve protectors.
- Conductive bins and other assembly or soldering aids.
- Nonconductive foam.
- Conductive tabletop workstations with ground cords of one-megohm resistance.
- Static-dissipative tables or floor mats with hard ties to the ground.
- Field service kits.
- Static awareness labels.
- Material-handling packages.
- Nonconductive plastic bags, tubes, or boxes.
- Metal tote boxes.
- Electrostatic voltage levels and protective materials.

Table 4-1 shows how humidity affects the electrostatic voltage levels generated by different activities.

Table 4-1 Typical Electrostatic Voltage Levels

	Relative Humidity		
Event	10%	40%	55%
Walking across carpet	35,000 V	15,000 V	7,500 V
Walking across vinyl floor	12,000 V	5,000 V	3,000 V
Motions of bench worker	6,000 V	800 V	400 V
Removing DIPS from plastic tube	2,000 V	700 V	400 V
Removing DIPS from vinyl tray	11,500 V	4,000 V	2,000 V
Removing DIPS from Styrofoam	14,500 V	5,000 V	3,500 V
Removing bubble pack from PCB	26,500 V	20,000 V	7,000 V
Packing PCBs in foam-lined box	21,000 V	11,000 V	5,000 V
A product can be degraded by as little as 700 V.			

Table 4-2 lists the shielding protection provided by antistatic bags and floor mats.

Table 4-2 Static-Shielding Materials

Material	Use	Voltage Protection Level
Antistatic plastic	Bags	1,500 V
Carbon-loaded plastic	Floor mats	7,500 V
Metallized laminate	Floor mats	5,000 V

Removal and Replacement Procedures

This chapter provides removal and replacement procedures.

There are 62 screws in eight different sizes that must be removed, replaced, and loosened when servicing the notebook. Make note of each screw size and location during removal and replacement.

Refer to Appendix C, "Screw Listing" for detailed information on screw sizes, locations, and usage.

5.1 Serial Number

Report the notebook serial number to HP when requesting information or ordering spare parts. The serial number is located on the bottom of the notebook.



Serial Number Location

5.2 Disassembly Sequence Chart

Use the chart below to determine the section number to be referenced when removing notebook components.

Disassembly Sequence Chart

Description	# of Screws Removed	
Preparing the notebook for disassemb	oly	
Battery pack Hard drive	0 1 to remove	

Occion	Description	1101110100	
5.3	5.3 Preparing the notebook for disassembly		
	Battery pack Hard drive	0 1 to remove 4 screws and 2 alignment pins to disassemble	
5.4	Notebook feet	0	
5.5	MultiBay device	0	
5.6	Bluetooth board	3	
5.7	Integrated smart card	0	
5.8	Optical drive	1	
5.9	Keyboard	1	
5.10	Memory expansion board	0	
5.11	Modem board	2	
5.12	Mini PCI communications board	2	
5.13	Heat sink	5	
5.14	Processor	0	
5.15	LED switch cover	1	
5.16	RTC battery	0	
5.17	Security Module (TPM)	1	
5.18	Display assembly	4	
5.19	Top cover	18	

Section

Fan assembly

System board

5.22

5.23

Disassembly Sequence Chart (Continued) Section Description # of Screws Removed 5.20 Speaker 6 5.21 TouchPad 3

4

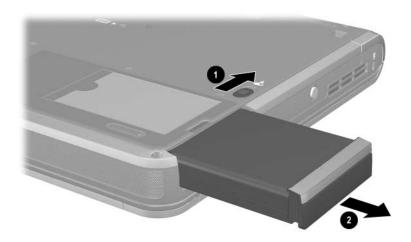
5.3 Preparing the Notebook for Disassembly

Before you begin any removal or installation procedures:

- 1. Save your work, exit all applications, and shut down the notebook. If you are not sure whether the notebook is off or in hibernation, briefly press the power button. If your work returns to the screen, save your work, exit all applications, and then shut down the notebook.
- 2. Disconnect all external devices connected to the notebook.
- 3. Disconnect the power cord.

Spare Part Number Infor	mation
Battery pack, 8-cell, 4.4 Wh, Li-lon	338669-001
Battery pack, 8-cell, 4.8AHR	360663-001

- 4. Remove the battery pack by following these steps:
 - a. Turn the notebook upside down with the front facing you.
 - b. Slide and hold the battery release latch **1** toward the back of the notebook.
 - c. Use the notch in the battery pack to slide the battery pack to the right **2**.
 - d. Remove the battery pack.



Removing the Battery Pack

5. Remove the battery bezel by sliding it down and off of the battery pack.



The battery bezel is included in the Miscellaneous Plastics Kit, spare part number 345066-001.



Removing the Battery Bezel

Reverse the above procedure to install the battery pack and battery bezel.

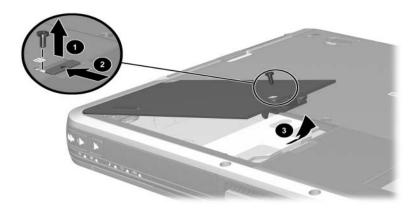
6. Remove the hard drive by following these steps:

Spare Par	t Number Informatio	n
Hard drives (includes hard drives	ve bezel and frame)	
80-GB 5400-rpm	(all models)	345632-001
60-GB 5400-rpm	(all models)	345631-001
40-GB 5400-rpm	(all models)	345630-001
60-GB 7200-rpm	(nw8000 only)	345855-001

- a. Turn the notebook upside down with the front facing you.
- b. Remove the T8M2.0×6.0 hard drive cover screw **①**.
- Slide and hold the tab on the hard drive cover to the left ②.
- d. Swing the right edge of the hard drive cover up and to the left **3**.

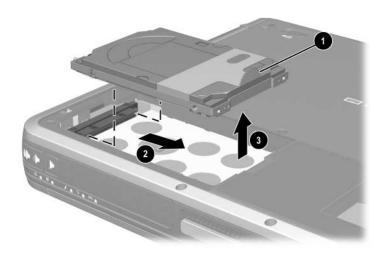


The hard drive cover is included in the Miscellaneous Plastics Kit, spare part number 345066-001.



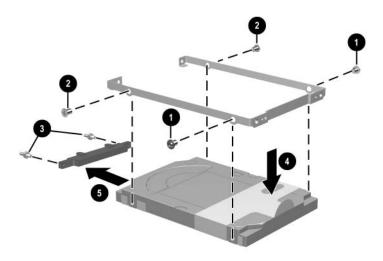
Removing the Hard Drive Cover

- e. Use the Mylar tab **1** to slide the hard drive to the right **2** to disconnect it from the system board.
- f. Lift the hard drive straight up to remove it **3**.



Removing the Hard Drive

- g. Remove the two T5M2.5×4.0 screws **1** and the two PM3.0×3.5 screws **2** that secure the hard drive to the hard drive frame.
- h. Use a 4.0-mm socket to remove the two M2.0×10.0 alignment pins 3 that secure the hard drive to the hard drive frame.
- i. Remove the hard drive **4** from the hard drive frame.
- j. Remove the hard drive connector **6** from the hard drive.

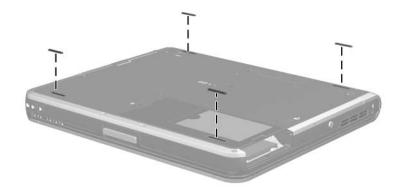


Disassembling the Hard Drive

Reverse the above procedure to assemble and install the hard drive.

5.4 Notebook Feet

The notebook feet are adhesive-backed rubber pads. The feet are included in the Miscellaneous Plastics Kit, spare part number 345066-001. The feet attach to the base enclosure as illustrated below.

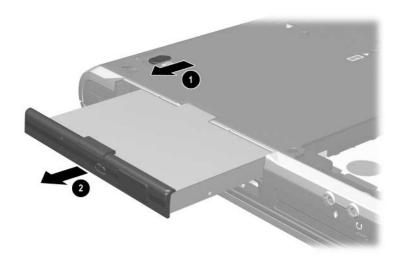


Notebook Feet Locations

5.5 MultiBay Device

Spare Part Number Information	
1.44-MB diskette drive	135233-001
24X Max CD-ROM Drive	228746-001
8X Max DVD+RW/R and CD-RW Combo Drive	251292-001
24X Max DVD+RW/R and CD-RW Combo Drive	344256-001

- 1. Prepare the notebook for disassembly (refer to Section 5.3).
- 2. Turn the notebook upside down with the left side facing you.
- 3. Slide and hold the MultiBay release latch toward you **①**.
- 4. Use the notch in the MultiBay device to slide the device out of the MultiBay 2.
- 5. Remove the MultiBay device.



Removing a MultiBay Device

Reverse the above procedure to install a MultiBay device.

5.6 Bluetooth Board

Spare Part Number Information

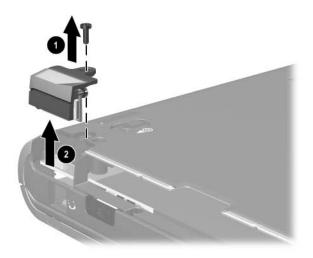
Bluetooth board (includes cable)

348277-001

- 1. Prepare the notebook for disassembly (refer to Section 5.3).
- 2. Turn the notebook upside down with the left side facing you.
- 3. Remove the T8M2.0×6.0 screw **1** that secures the Bluetooth cover to the notebook.
- 4. Lift the cover straight up to remove it **2**.



The Bluetooth cover is included in the Miscellaneous Plastics Kit, spare part number 345066-001.



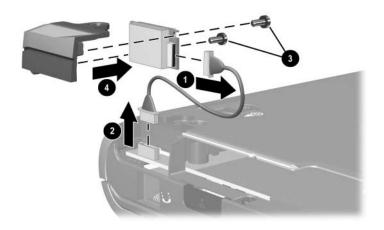
Removing the Bluetooth Cover

5. Disconnect the Bluetooth cable from the Bluetooth board **1** and the system board **2**.



The Bluetooth cable is included with the Bluetooth board and is also included in the Miscellaneous Cables Kit, spare part number 345056-001.

- 6. Remove the two PM1.5×3.0 screws **3** that secure the Bluetooth board to the Bluetooth cover.
- 7. Remove the board from the cover **4**.



Removing the Bluetooth Board

Reverse the above procedure to install the Bluetooth board.

5.7 Integrated Smart Card

Spare Part Number Information

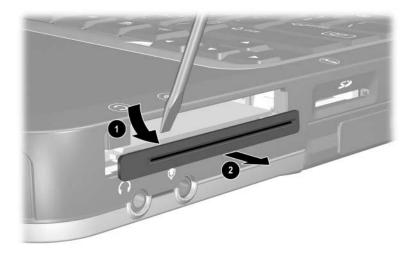
Integrated smart card

379336-001



The integrated smart card is located in the bottom PC Card slot.

- 1. Prepare the notebook for disassembly (refer to Section 5.3).
- 2. Remove any PC Card or spacer from the top PC Card slot.
- 3. Using a flat-bladed tool, pry the smart card bezel off of the notebook **①**. The bezel releases from the notebook with a small amount of force.
- 4. Remove the bezel from the notebook **2**.

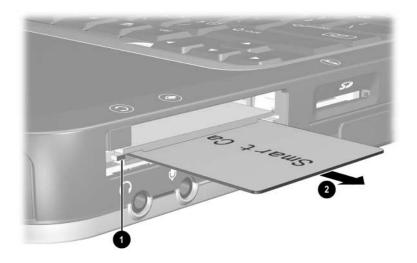


Removing the Smart Card Bezel



The integrated smart card bezel is included in the Miscellaneous Plastics Kit, spare part number 345066-001.

- 5. Eject the smart card from the notebook using a flat-bladed tool to press the small metal eject tab to the left of the smart card.
- 6. Remove the card from the slot **2**.



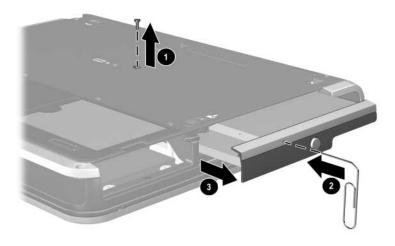
Removing the Smart Card

Reverse the above procedure to install the integrated smart card.

5.8 Optical Drive

Spare Part Number Information		
24X Max DVD+RW/R and CD-RW Combo Drive	349242-001	
8X Max DVD-ROM Drive	349241-001	
24X Max DVD/CD-RW Combo Drive	349243-001	
24X Max CD-ROM Drive	349240-001	

- 1. Prepare the notebook for disassembly (refer to Section 5.3).
- 2. Turn the notebook upside down with the right side facing you.
- 3. Remove the T8M2.0×6.0 screw **1** that secures the optical drive to the notebook.
- 4. Insert a paper clip or similar tool into the optical drive release hole to open the optical drive tray **2**.
- 5. Use the optical drive tray to remove the optical drive **3**.



Removing the Optical Drive

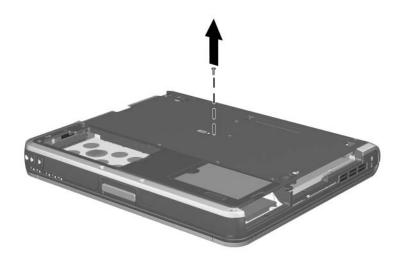
Reverse the above procedure to install the optical drive.

5.9 Keyboard

Keyboards (include pointing stick)				
Keyboards (include parazil Czech Republic Denmark Europe France French Canada Germany Greece Greece - Blk	341520-201 341520-221 341520-281 341520-081 341520-051 341520-051 341520-121 341520-041 378539-151 373646-151	Korea Latin America Norway Portugal Russia Saudi Arabia Slovenia Spain Sweden/Finland	341520-AD1 341520-161 341520-091 341520-131 341520-251 341520-171 341520-BA1 341520-071 341520-B71	
Hungary Iceland International Israel Italy Japan	341520-211 341520-DD1 341520-B31 341520-BB1 341520-061 341520-291	Switzerland Taiwan Thailand Turkey United Kingdom United States	341520-BG1 341520-AB1 341520-281 341520-141 341520-031 341520-001	

- 1. Prepare the notebook for disassembly (refer to Section 5.3).
- 2. Turn the notebook upside down with the front facing you.

3. Remove the T8M2.×6.0 screw that secures the keyboard to the notebook.



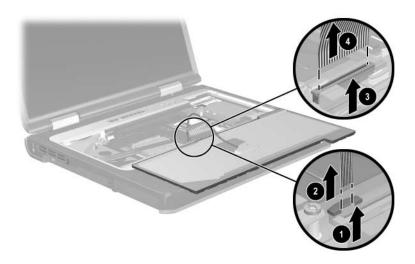
Removing the Keyboard Screw

- 4. Turn the notebook right-side up with the front facing you.
- 5. Open the notebook.
- 6. Slide the four tabs **1** on the top edge of the keyboard toward you.
- 7. Lift the rear edge of the keyboard up and swing it toward you 2 until it rests on the palm rest.



Releasing the Keyboard

- 8. Release the zero insertion force (ZIF) connector **1** to which the pointing stick cable is attached and disconnect the cable **2**.
- 9. Release the ZIF connector **3** to which the keyboard cable is attached and disconnect the cable **4**.



Disconnecting the Keyboard Cables

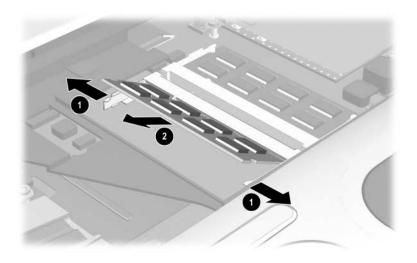
10. Remove the keyboard.

Reverse the above procedure to install the keyboard.

5.10 Memory Expansion Board

Spare Part Number Information 1024 MB (1.0 GB), 333 MHz 336579-001 512 MB, 333 MHz 336578-001 256 MB, 333 MHz 336577-001

- 1. Prepare the notebook for disassembly (refer to Section 5.3).
- 2. Release the keyboard (refer to Section 5.9).
- 3. Spread the retaining tabs **1** that secure the memory expansion board to the socket. The free end of the board rises.
- 4. Pull the board away from the socket at a 45-degree angle **②**.



Removing a Memory Expansion Board

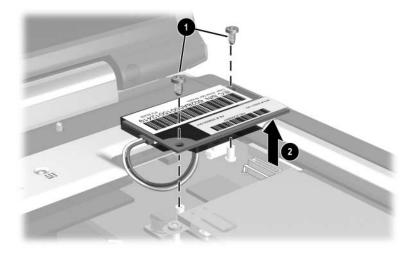
Reverse the above procedure to install a memory expansion board.

5.11 Modem Board

Spare Part Number Information

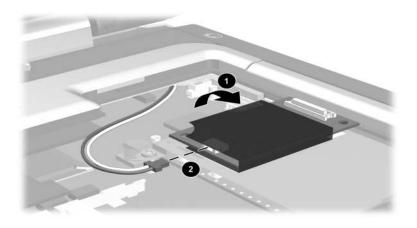
Modem board 325521-001

- 1. Prepare the notebook for disassembly (refer to Section 5.3).
- 2. Release the keyboard (refer to Section 5.9).
- 3. Remove the two T8M2.0×4.0 screws **1** that secure the modem board to the notebook.
- 4. Lift up on the right side of the modem board ② to disconnect the board from the system board.



Removing the Modem Board Screws

- 5. Turn the modem board upside down **1**.
- 6. Disconnect the modem cable **2** from the modem.



Disconnecting the Modem Board Cable

7. Remove the modem board.

Reverse the above procedure to install the modem board.

5.12 Mini PCI Communications Board

Spare Part Number Information			
802.11a/b/g LAN NIC	325525-001		
802.11b/g LAN NIC	325526-001		
802.11b W500 modem board (for use in Japan)	339742-291		
802.11b wireless LAN (MOW)	345641-001		
802.11b wireless LAN (ROW)	345640-001		
802.11b/g wireless modem (MOW)	368247-001		
802.11b/g wireless modem (ROW)	368248-001		

- 1. Prepare the notebook for disassembly (refer to Section 5.3).
- 2. Release the keyboard (refer to Section 5.9).

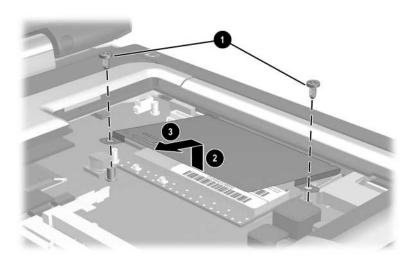


Some computer models have two Torx7 with pin security screws (M2.0×4.0) securing the Mini PCI communications board to the computer. A T7 pin bit screw driver is required to remove the Mini PCI communications board on these computer models.

- 3. Remove the two T8M2.0×4.0 screws **1** that secure the Mini PCI communications board shield to the notebook.
- 4. Lift up on the left side of the shield **2** and slide it to the left **3** to remove it.

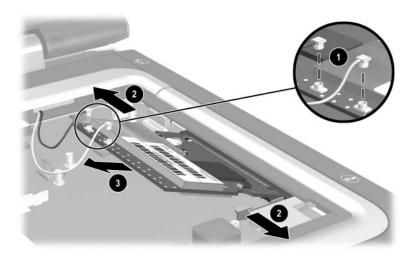


The Mini PCI communications board shield is included in the Miscellaneous Plastics Kit, spare part number 345066-001.



Removing the Mini PCI Communications Board Shield

- 5. Disconnect the two antenna cables **1** from the board. Make note of which cable connects to which terminal.
- 6. Spread the retaining tabs ② that secure the Mini PCI communications board to the socket. The free end of the board rises.
- 7. Pull the board away from the socket at a 45-degree angle **3**.



Removing the Mini PCI Communications Board

8. Remove the Mini PCI communications board.

Reverse the above procedure to install the Mini PCI communications board.

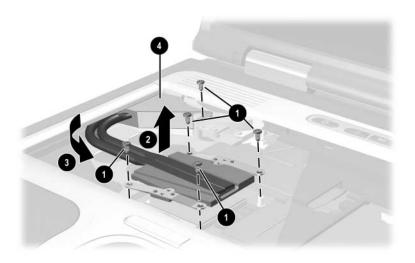
5.13 Heat Sink

Spare Part Number Information

Heat sink (includes grease)

345067-001

- 1. Prepare the notebook for disassembly (refer to Section 5.3).
- 2. Release the keyboard (refer to Section 5.9).
- 3. Remove the five T8M2.0×4.0 screws **●** that secure the heat sink to the notebook.
- 4. Lift the front edge of the heat sink 2 to unseat the adhesive grip of the thermal grease on the processor.
- 5. Swing the heat sink in a counterclockwise motion 3 until the back of the heat sink 4 clears the notebook.

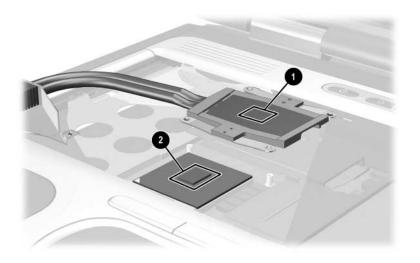


Removing the Heat Sink

6. Remove the heat sink.



Carefully clean any thermal grease residue from the heat sink **1** and processor surfaces **2** each time you remove the heat sink. Apply new thermal grease to both surfaces.



Removing the Thermal Grease From the Heat Sink and Processor Reverse the above procedure to install the heat sink.

5.14 Processor

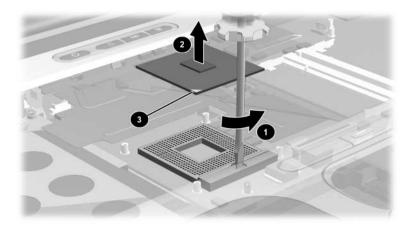
Spare Part Number Information Processors (include grease) Intel Pentium M (Banias) processor, 1.7 GHz 340165-001 Intel Pentium M (Banias) processor, 1.6 GHz 319777-001 Intel Pentium M (Banias) processor, 1.5 GHz 319776-001 Intel Pentium M (Banias) processor, 1.4 GHz 319775-001 Intel Pentium M (Dothan) processor, 1.5 GHz 359636-001 Intel Pentium M (Dothan) processor, 1.6 GHz 356596-001 Intel Pentium M (Dothan) processor, 1.7 GHz 356597-001 Intel Pentium M (Dothan) processor, 1.8 GHz 345857-001 Intel Pentium M (Dothan) processor, 2.0 GHz 353395-001

- 1. Prepare the notebook for disassembly (refer to Section 5.3).
- 2. Release the keyboard (refer to Section 5.9).
- 3. Remove the heat sink (refer to Section 5.13).

- 4. Use a flat-bladed screwdriver to turn the processor locking screw one-quarter turn counterclockwise **①**.
- 5. Remove the processor from the system board socket **②**.



Note that the gold triangle 3 on the processor should be aligned in the front left corner when you install the processor.



Removing the Processor

Reverse the above procedure to install the processor.

5.15 LED Switch Cover

Spare Part Number Information

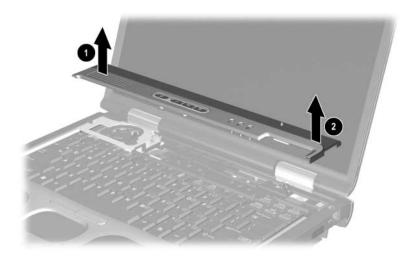
LED switch cover 345063-001

- 1. Prepare the notebook for disassembly (refer to Section 5.3).
- 2. Turn the notebook upside down with the rear facing you.
- 3. Remove the T8M2.0×6.0 screw that secures the LED switch cover to the notebook.



Removing the LED Switch Cover Screw

- 4. Turn the notebook right-side up with the front facing you.
- 5. Open the notebook.
- 6. Lift the left **1** and right **2** sides of the LED switch cover to disengage the cover from the notebook.
- 7. Remove the LED switch cover.



Removing the LED Switch Cover

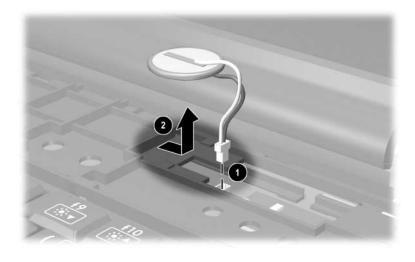
Reverse the above procedure to install the LED switch cover.

5.16 RTC Battery



The RTC battery is included in the Miscellaneous Plastics Kit, spare part number 345066-001.

- 1. Prepare the notebook for disassembly (refer to Section 5.3).
- 2. Remove the LED switch cover (refer to Section 5.15).
- 3. Disconnect the RTC battery cable **1** from the system board.
- 4. Slide the RTC battery out of the clips in the top cover ② and remove the battery.



Removing the RTC Battery

Reverse the above procedure to install the RTC battery.

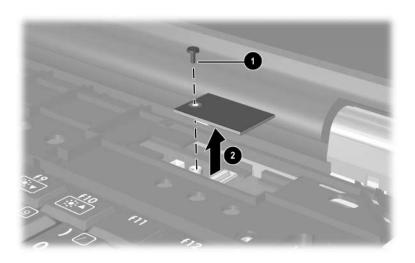
5.17 Security Module (TPM)

Spare Part Number Information

Security Module (TPM)

345856-001

- 1. Prepare the notebook for disassembly (refer to Section 5.3).
- 2. Remove the LED switch cover (refer to Section 5.15).
- 3. Remove the PM3.5×3.0 screw **①** that secures the security card to the system board.
- 4. Lift the security module straight up **2** to disconnect it from the system board.



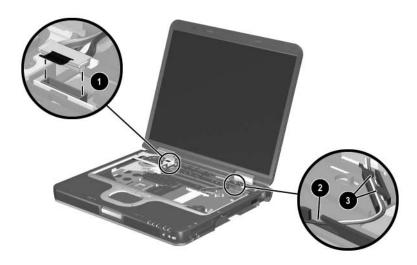
Removing the TPM Security Module

Reverse the above procedure to install the security card.

5.18 Display Assembly

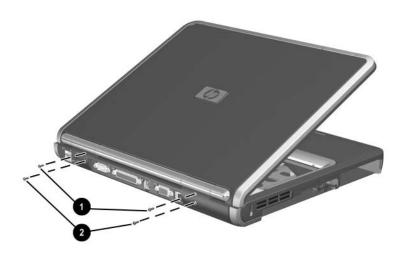
Spare Part Number Information			
15.0-inch, UXGA, TFT	345060-001		
15.0-inch, SXGA+, TFT	345059-001		
15.0-inch, XGA, TFT	345058-001		

- 1. Prepare the notebook for disassembly (refer to Section 5.3).
- 2. Remove the keyboard (refer to Section 5.9).
- 3. Disconnect the wireless antenna cables from the Mini PCI wireless communications board (refer to Section 5.12).
- 4. Remove the LED switch cover (refer to Section 5.15).
- 5. Disconnect the display cable **1** from the system board.
- 6. Remove the wireless antenna cables from the opening ② and the clips ③ in the top cover.



Disconnecting the Display Cables

- 7. Position the notebook with the rear facing toward you.
- 8. Remove the two T8M2.0×6.0 screws **1** that secure the display hinge covers to the notebook.
- 9. Remove the two T8M2.0×6.0 screws ② that secure the display assembly to the notebook.

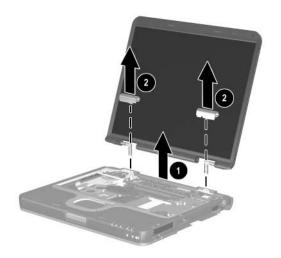


Removing the Display Screws

- 10. Lift the display assembly straight up **1** to remove it from the notebook.
- 11. If necessary, remove the display hinge covers ② from the display assembly.



The display hinge covers are included in the Miscellaneous Plastics Kit, spare part number 345066-001.



Removing the Display Assembly

Reverse the above procedure to install the display assembly.

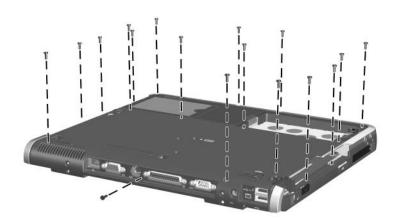
5.19 Top Cover

Spare Part Number Information

Top cover (includes TouchPad and speaker)

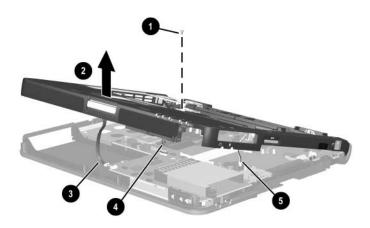
345061-001

- 1. Prepare the notebook for disassembly (refer to Section 5.3).
- 2. Remove the keyboard (refer to Section 5.9).
- 3. Remove the LED switch cover (refer to Section 5.15).
- 4. Remove the display assembly (refer to Section 5.18).
- 5. Turn the notebook upside down with the front facing you.
- 6. Remove the 17 T8M2.0×6.0 screws that secure the top cover to the notebook.



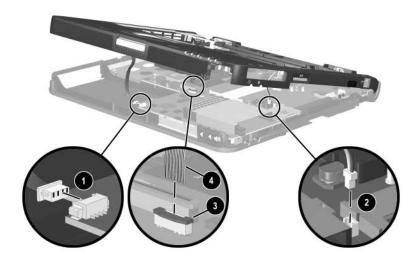
Removing the Top Cover Screws

- 7. Turn the notebook right-side up with the front facing you.
- 8. Remove the TM2.0×4.0 screw **1** near the fan that secures the top cover to the notebook.
- 9. Lift the front edge of the top cover ② until the speaker cable ③, TouchPad cable ④, and microphone cable ⑤ are accessible.



Releasing the Top Cover

- 10. Disconnect the speaker **1** and microphone cables **2**.
- 11. Release the ZIF connector **3** to which the TouchPad cable is attached and disconnect the TouchPad cable **4** from the system board.



Disconnecting the Top Cover Cables

12. Remove the top cover.

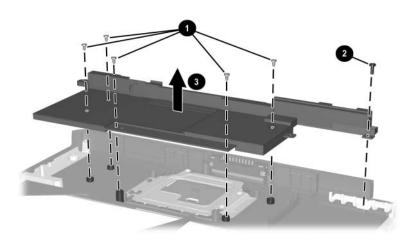
Reverse the above procedure to install the top cover.

5.20 Speaker



The speaker is included with the top cover, spare part number 345061-001.

- 1. Prepare the notebook for disassembly (refer to Section 5.3) and remove the following components:
 - ☐ Keyboard (refer to Section 5.9)
 - ☐ LED switch cover (refer to Section 5.15)
 - ☐ Display assembly (refer to Section 5.18)
 - \Box Top cover (refer to Section 5.19)
- 2. Turn the top cover upside down with the rear facing you.
- 3. Remove the five T8M2.0×4.0 screws **①** and one T8M2.0×6.0 screw **②** that secure the speaker to the top cover.
- 4. Remove the speaker **3** from the top cover.



Removing the Speaker

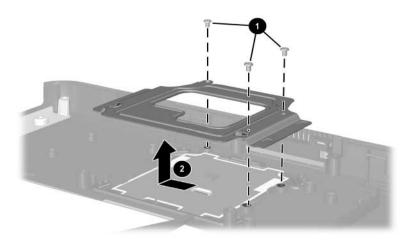
Reverse the above procedure to install the speaker.

5.21 TouchPad



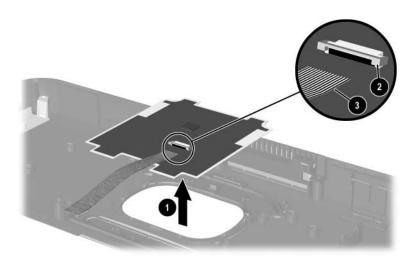
The TouchPad and bracket are included with the top cover, spare part number 345061-001.

- 1. Prepare the notebook for disassembly (refer to Section 5.3) and remove the following components:
 - ☐ Keyboard (refer to Section 5.9)
 - ☐ LED switch cover (refer to Section 5.15)
 - ☐ Display assembly (refer to Section 5.18)
 - \Box Top cover (refer to Section 5.19)
 - □ Speaker (refer to Section 5.20)
- 2. Remove the three Torx T8M2.0×3.5 screws that secure the TouchPad and bracket to the top cover.
- 3. Lift the left side of the bracket ②, then slide the bracket to the left.



Removing the TouchPad Bracket

- 4. Remove the bracket.
- 5. Remove the TouchPad from the top cover.
- 6. Release the ZIF connector **②** to which the TouchPad cable is attached and disconnect the cable **③**.



Removing the TouchPad

Reverse the above procedure to install the TouchPad and bracket.

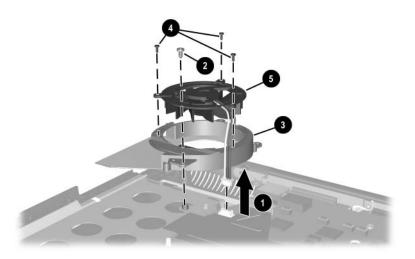
Fan assembly

5.22 Fan Assembly

Spare Part Number Information 345065-001

- 1. Prepare the notebook for disassembly (refer to Section 5.3) and remove the following components:
 - ☐ Keyboard (refer to Section 5.9)
 - ☐ Heat sink (refer to Section 5.13)
 - ☐ LED switch cover (refer to Section 5.15)
 - ☐ Display assembly (refer to Section 5.18)
 - \Box Top cover (refer to Section 5.19)

- 2. Disconnect the fan cable **1**.
- 3. Remove the T8M2.0×4.0 screw ② that secures the fan assembly to the notebook.
- 4. Remove the fan assembly **3** from the notebook.
- 5. Remove the three PM1.5×4.0 screws **4** that secure the fan to the fan housing.
- 6. Remove the fan **6**.



Removing the Fan

Reverse the above procedure to install the fan.

5.23 System Board

Spare Part Number Information

System board with 128 MB of video memory System board with 64 MB of video memory 349206-001 345064-001



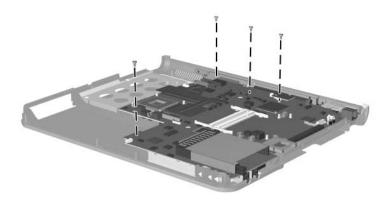
Both system boards include thermal grease.



When replacing the system board, ensure that the following components are removed from the defective system board and installed on the replacement system board:

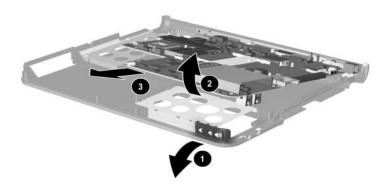
- Memory expansion boards (refer to Section 5.10)
- Modem board (refer to Section 5.11)
- Mini PCI communications board (refer to Section 5.12)
- Heat sink (refer to Section 5.13)
- Processor (refer to Section 5.14)
- Real time clock battery (refer to Section 5.16)
- Security card (refer to Section 5.17)
 - 1. Prepare the notebook for disassembly (refer to Section 5.3) and remove the following components:
 - ☐ Keyboard (refer to Section 5.9)
 - ☐ LED switch cover (refer to Section 5.15)
 - ☐ Display assembly (refer to Section 5.18)
 - \Box Top cover (refer to Section 5.19)
 - ☐ Fan (refer to Section 5.22)

2. Remove the four T8M2.0×4.0 screws that secure the system board to the notebook.



Removing the System Board Screws

- 3. Flex and hold the front right corner of the base enclosure out **1** to allow the system board to clear the base enclosure.
- 4. Lift the front edge of the system board ② until the board clears the base enclosure.
- 5. Slide the system board toward you **3** to remove it from the notebook.

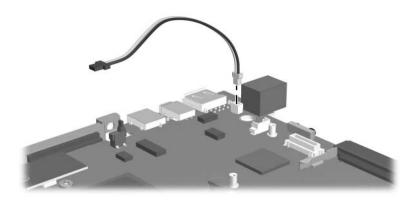


Removing the System Board

6. If necessary, disconnect the modem cable from the system board and remove the cable.



The modem cable is included in the Miscellaneous Cables Kit, spare part number 345056-001.



Removing the Modem Cable

Reverse the above procedure to install the modem cable and system board.

Specifications

This chapter provides physical and performance specifications.

Table 6-1 Notebook					
Dimensions					
Height Width Depth	4.1 cm 32.6 cm 27.5 cm	1.61 in 12.83 in 10.83 in			
Weight (with main battery pack and MultiBay weight saver)					
	2.95 kg	6.50 lb			
Stand-alone power requ	irements				
Nominal operating voltage (Li-lon) Maximum operating	14.4 VDC 60.0 W				
power Peak operating power	65.0 W				
Temperature					
Operating (not writing optical drive)	10°C to 35°C	50°F to 95°F			
Nonoperating	-20°C to 60°C	-4°F to 140°F			
Relative humidity (noncondensing)					
Operating Nonoperating	10% to 90% 5% to 90%, 38.7°C (101.6°F) maximum wet bulb temperature				

Table 6-1 Notebook (Continued)

Altitude (unpressurized)

Operating (14.7 to 0 to 3,048 m 0 to 10,000 ft

10.1 psia)

Nonoperating (14.7 to 0 to 9,144 m 0 to 30,000 ft

4.4 psia)

Shock

Operating 40 g, 2 ms, half-sine Nonoperating 240 g, 2 ms, half-sine



Applicable product safety standards specify thermal limits for plastic surfaces. The notebook operates well within this range of temperatures.

Table 6-2			
15.0-inch,	UXGA,	TFT	Display

Dimensions		
I I a tanka	00.0	44.0 to
Height Width	29.9 cm 22.8 cm	11.8 in 9.0 in
	22.6 Cm	9.0 m 15.0 in
Diagonal	36.1 (111	15.0 111
Number of colors	Up to 16.8 million	
Contrast ratio	250:1	
Brightness	140 nits typical	
Pixel resolution		
Pitch	0.191 × 0.191 mm	
Format	1680 × 1200	
Configuration	RGB vertical stripe	
	·	
Backlight	Edge lit	
Character display	80 × 25	
Total power consumption	6.5 W	
Viewing angle	+/- 85° horizontal, +15/-35° vertical typical	

Table 6-3	
15.1-inch, SXGA+, TFT	Display

Dimensions		
Height	29.9 cm	11.8 in
Width	22.8 cm	9.0 in
Diagonal	38.1 cm	15.0 in
Number of colors	Up to 16.8 million	
Contrast ratio	150:1	
Brightness	150 nits typical	
Pixel resolution		
Pitch	0.218 × 0.218 mm	
Format	1400 × 1050	
Configuration	RGB vertical stripe	
Backlight	Edge lit	
Character display	80 × 25	
Total power consumption	5.75 W	
Viewing angle	+/- 35° horizontal, +15/-35° vertical typical	

15.0-inch, XGA, TFT Display			
Dimensions			
Height Width Diagonal	29.9 cm 22.8 cm 38.1 cm	11.8 in 9.0 in 15.0 in	
Number of colors	Up to 16.8 million		
Contrast ratio 150:1			
Brightness	150 nits typical		

Table 6-4

Pixel resolution

> Pitch $0.264 \times 0.264 \text{ mm}$ Format 1280×800 Configuration RGB vertical stripe

Edge lit Backlight 80×25

Character display Total power 5.75 W consumption

Viewing angle +/- 35° horizontal, +15/-35° vertical typical

Hard Drives			
	80-GB	60-GB	40-GB
User capacity per drive ¹	80 GB	60 GB	40 GB
Dimensions			
Height Width Weight	9.5 mm 70 mm 99 g	9.5 mm 70 mm 99 g	9.5 mm 70 mm 99 g
Interface type	ATA-5	ATA-5	ATA-5
Transfer rate			
Synchronous (maximum) Security	100 MB/s ATA security	100 MB/s ATA security	100 MB/s ATA security
Seek times (typical read, include	ding setting)		
Single track Average Maximum	3 ms 13 ms 24 ms	3 ms 13 ms 24 ms	3 ms 13 ms 24 ms
Logical blocks ²	156,280,320	117,210,240	78,140,160
Disk rotational speed	5400 rpm	5400 rpm	5400 rpm
Operating temperature	5°C to 55°C (41°F to 131°F)	5°C to 55°C (41°F to 131°F)	5°C to 55°C (41°F to 131°F)

Table 6-5

Certain restrictions and exclusions apply. Consult the HP Customer Support Center for details.

¹1 GB = 1,073,741,824 bytes.

²Actual drive specifications may differ slightly.

Table 6-6
External AC Adapter

١Λ	\boldsymbol{a}		ht
٧١	ᆫ	ıu	IIL

AC adapter 0.29 kg 0.65 lb Power cord 0.13 kg 0.29 lb

Power supply

Operating voltage 90 to 264 VAC RMS
Operating current 1.6 A RMS

Operating frequency range 47 to 63 Hz AC Maximum transient 4/50 kV

Table 6-7 6-cell, Li-Ion Battery Pack

Dimensions		
Height Width Depth Weight	2.3 cm 6.3 cm 20.7 cm 0.39 kg	0.90 in 2.48 in 8.15 in 0.86 lb
Energy		
Voltage Amp-hour capacity Watt-hour capacity	11.1 V 3.96 Ah 40 Wh	
Temperature		
Operating Nonoperating	5°C to 45°C -20°C to 60°C	41°F to 113°F -4°F to 140°F
Recharge time		
System in Standby mode System on (depending on	2 to 3 hours 2 to 5 hours	

system power consumption)

Table 6-8		
24X Max DVD+RW/R and CD-RW Combo Drive		

Z+X Max BVB+HW/H and OB HW Combo Bive			
Applicable disc	DVD-5, DVD-9, DVD-10 CD-ROM (Mode 1 and 2) CD Digital Audio CD-XA ready (Mode 2, Form 1 and 2) CD-I ready (Mode 2, Form 1 and 2) CD-R (read only) CD Plus Photo CD (single/multisession) CD-Bridge		
Center hole diameter	1.5 cm	0.59 in	
Disc diameter			
Standard disc	12 cm	4.72 in	
Mini disc	8 cm	3.15 in	
Disc thickness	1.2 mm	0.047 in	
Track pitch	0.74 μm	0.74 μm	
Access time			
Random	< 150 ms		
Full stroke	< 225 ms		
Audio output level	Line-out, 0.7 Vrms		
Cache buffer	128 KB/s		
Data transfer rate			
CD-R (24X)	3,600 KB/s (150 KB/s at 1X CD rate)		
CD-RW (10X)	1,500 KB/s (150 KB/s at 1X CD rate)		
CD-ROM (24X)	3,600 KB/s (150 KB/s at 1X CD rate)		
DVD (8X)	10,800 KB/s (1,352 KB/s at 1X DVD rate)		
Multiword DMA mode 2	16.6 MB/s		
Startup time	< 15 seconds		
Stop time	< 6 seconds		

Table 6-9		
24X Max DVD/CD-RW Combo D	rive	

	2 1% max 2 0 2/02 1111 Com20 21110			
Applicable disc	DVD-5, DVD-9, DVD-10 CD-ROM (Mode 1 and 2) CD Digital Audio CD-XA ready (Mode 2, Form 1 and 2) CD-I ready (Mode 2, Form 1 and 2) CD-R (read only) CD Plus Photo CD (single/multisession) CD-Bridge			
Center hole diameter	1.5 cm	0.59 in		
Disc diameter				
Standard disc	12 cm	4.72 in		
Mini disc	8 cm	3.15 in		
Disc thickness	1.2 mm	0.047 in		
Track pitch	0.74 μm			
Access time				
Random	< 150 ms			
Full stroke	< 225 ms			
Audio output level	Line-out, 0.7 Vrm	s		
Cache buffer	128 KB/s			
Data transfer rate				
CD-R (24X)	3,600 KB/s (150 k	(B/s at 1X CD rate)		
CD-RW (10X)	1,500 KB/s (150 KB/s at 1X CD rate)			
CD-ROM (24X)	3,600 KB/s (150 KB/s at 1X CD rate)			
DVD (8X)	10,800 KB/s (1,35 rate)	52 KB/s at 1X DVD		
Multiword DMA mode 2	16.6 MB/s			
Startup time	< 15 seconds			
Stop time	< 6 seconds			

Table 6-10 8X DVD-ROM Drive		
Applicable disc	DVD-5, DVD-9, DVD-10 CD-ROM (Mode 1 and 2) CD Digital Audio CD-XA ready (Mode 2, Form 1 and 2) CD-I ready (Mode 2, Form 1 and 2) CD-R (read only) CD Plus Photo CD (single/multisession) CD-Bridge	
Center hole diameter	1.5 cm	0.59 in
Disc diameter		
Standard disc Mini disc	12 cm 8 cm	4.72 in 3.15 in
Disc thickness	1.2 mm	0.047 in
Track pitch	0.74 μm	
Access time		
Random DVD media Full stroke DVD media Random CD media Full stroke CD media	< 150 ms < 225 ms < 110 ms < 200 ms	
Audio output level	Line-out, 0.7 Vrr	ms
Cache buffer	512 KB/s	
Data transfer rate		
Max 24X CD Max 8X DVD	3,600 KB/s (150 KB/s at 1X CD rate) 10,800 KB/s (1,352 KB/s at 1X DVD rate)	
Multiword DMA mode 2	16.6 MB/s	
Startup time	< 10 seconds	
Stop time	< 3 seconds	

Table 6-11 24X CD-ROM Drive			
Applicable disc	DVD-5, DVD-9, DVD-10 CD-ROM (Mode 1 and 2) CD Digital Audio CD-XA ready (Mode 2, Form 1 and 2) CD-I ready (Mode 2, Form 1 and 2) CD-R (read only) CD Plus Photo CD (single/multisession) CD-Bridge		
Center hole diameter	1.5 cm 0.59 in		
Disc diameter			
Standard disc	12 cm 4.72 in		
Mini disc	8 cm 3.15 in		
Disc thickness	1.2 mm 0.047 in		
Track pitch	1.6 µm		
Access time			
Random	< 150 ms		
Full stroke	< 300 ms		
Audio output level	Line-out, 0.7 Vrms		
Cache buffer	128 KB/s		
Data transfer rate			
Sustained (16X)	2,400 KB/s		
Variable	1,500 to 3,600 KB/s (10X to 24X)		
Multiword DMA mode 2	16.6 MB/s		
Startup time	< 8 seconds		
Stop time	< 4 seconds		

Table 6-12 System DMA

Hardware DMA	System Function	
DMA0	Available for audio	
DMA1*	Entertainment audio (default; alternate = DMA0, DMA3, none)	
DMA2*	Diskette drive	
DMA3	ECP parallel port LPT1 (default; alternate = DMA0, none)	
DMA4	DMA controller cascading (not available)	
DMA5*	Available for PC Card	
DMA6	Not assigned	
DMA7	Not assigned	
*PC Card controller can use DMA 1, 2, or 5.		

Tabl	le 6-13
System	Interrupts

Hardware IRQ	System Function
IRQ0	System timer
IRQ1	Keyboard controller
IRQ2	Cascaded
IRQ3	COM2
IRQ4	COM1
IRQ5	Audio (default)*
IRQ6	Diskette drive
IRQ7	Parallel port
IRQ8	RTC
IRQ9	Assigned by operating system
IRQ10	Assigned by operating system
IRQ11	Assigned by operating system
IRQ12	Internal point stick or external mouse
IRQ13	Infrared
IRQ14	Primary IDE interface
IRQ15	Secondary IDE interface
	PC Cards may assert IRQ3, IRQ4, IRQ5, IRQ7, IRQ9, IRQ10, IRQ11, or IRQ15. Either the infrared or the serial port may assert IRQ3 or IRQ4.

^{*}Default configuration; audio possible configurations are IRQ5, IRQ7, IRQ9, IRQ10, or none.

Table 6-14
System I/O Addresses

I/O Address (hex)	System Function (shipping configuration)
000 - 00F	DMA controller 1
010 - 01F	Unused
020 - 021	Interrupt controller 1
022 - 024	Opti chipset configuration registers
025 - 03F	Unused
02E - 02F	87334 "Super I/O" configuration for CPU
040 - 05F	Counter/timer registers
044 - 05F	Unused
060	Keyboard controller
061	Port B
062 - 063	Unused
064	Keyboard controller
065 - 06F	Unused
070 - 071	NMI enable/RTC
072 - 07F	Unused
080 - 08F	DMA page registers
090 - 091	Unused
092	Port A
093 - 09F	Unused
0A0 - 0A1	Interrupt controller 2

Table 6-14	
System I/O Addresses (Continued)

I/O Address (hex)	System Function (shipping configuration)
0A2 - 0BF	Unused
0C0 - 0DF	DMA controller 2
0E0 - 0EF	Unused
0F0 - 0F1	Coprocessor busy clear/reset
0F2 - 0FF	Unused
100 - 16F	Unused
170 - 177	Secondary fixed disk controller
178 - 1EF	Unused
1F0 - 1F7	Primary fixed disk controller
1F8 - 200	Unused
201	Joystick (decoded in ESS1688)
202 - 21F	Unused
220 - 22F	Entertainment audio
230 - 26D	Unused
26E - 26	Unused
278 - 27F	Unused
280 - 2AB	Unused
2A0 - 2A7	Unused
2A8 - 2E7	Unused
2E8 - 2EF	Reserved serial port

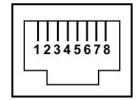
Table 6-14	
System I/O Addresses (Contine	ued)

I/O Address (hex)	System Function (shipping configuration)
2F0 - 2F7	Unused
2F8 - 2FF	Infrared port
300 - 31F	Unused
320 - 36F	Unused
370 - 377	Secondary diskette drive controller
378 - 37F	Parallel port (LPT1/default)
380 - 387	Unused
388 - 38B	FM synthesizer—OPL3
38C - 3AF	Unused
3B0 - 3BB	VGA
3BC - 3BF	Reserved (parallel port/no EPP support)
3C0 - 3DF	VGA
3E0 - 3E1	PC Card controller in CPU
3E2 - 3E3	Unused
3E8 - 3EF	Internal modem
3F0 - 3F7	"A" diskette controller
3F8 - 3FF	Serial port (COM1/default)
CF8 - CFB	PCI configuration index register (PCIDIVO-1)
CFC - CFF	PCI configuration data register (PCIDIVO-1)



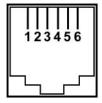
Connector Pin Assignments

Table A-1 RJ-45 Network Interface



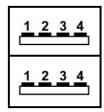
Pin	Signal	Pin	Signal
1	Transmit +	5	Unused
2	Transmit –	6	Receive –
3	Receive +	7	Unused
4	Unused	8	Unused

Table A-2 RJ-11 Modem



Pin	Signal	Pin	Signal
1	TX+ (ISDN modem)	4	Ring (modem)
2	TX- (ISDN modem)	5	RX+ (ISDN modem)
3	Tip (modem)	6	RX- (ISDN modem)

Table A-3 Universal Serial Bus



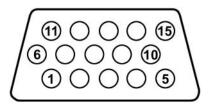
Pin	Signal	Pin	Signal
1	+5 VDC	3	Data +
2	Data –	4	Ground

Table A-4 S-Video



Pin	Signal	Pin	Signal
1	Ground (Y)	3	Y-Luminance (Intensity)
2	Ground (C)	4	C-Chrominance (Color)

Table A-5 External Monitor



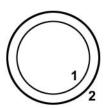
Pin	Signal	Pin	Signal
1	Red analog	9	+5 VDC
2	Green analog	10	Ground
3	Blue analog	11	Monitor detect
4	Not connected	12	DDC 2B data
5	Ground	13	Horizontal sync
6	Ground analog	14	Vertical sync
7	Ground analog	15	DDC 2B clock
8	Ground analog		

Table A-6 Audio Line-Out



Pin	Signal
1	Ground
2	Left audio out
3	Right audio out

Table A-7 Microphone



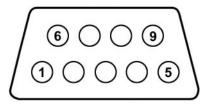
Pin	Signal	Pin	Signal
1	Audio in	2	Ground

Table A-8 Parallel



Pin	Signal	Pin	Signal
1	Strobe	14	Auto linefeed
2	Data bit 0	15	Error
3	Data bit 1	16	Initialize paper
4	Data bit 2	17	Select in
5	Data bit 3	18	Ground
6	Data bit 4	19	Ground
7	Data bit 5	20	Ground
8	Data bit 6	21	+5VS
9	Data bit 7	22	PTF
10	Acknowledge	23	EXTFDD_VCC (+5V)
11	Busy	24	Ground
12	Paper end	25	Ground
13	Select		

Table A-9 Serial



Pin	Signal	Pin	Signal
1	Carrier detect	6	Data set ready
2	Receive data	7	Ready to send
3	Transmit data	8	Clear to send
4	Data terminal ready	9	Ring indicator
5	Ground		

Power Cord Requirements

The wide range input feature of the notebook permits it to operate from any line voltage from 100 to 120 or 220 to 240 V AC.

The power cord included with the notebook meets the requirements for use in the country where the equipment is purchased.

Power cords for use in other countries must meet the requirements of the country where the notebook is used. For more information on power cord requirements, contact an HP authorized reseller or service provider.

General Requirements

The requirements listed below are applicable to all countries:

- The length of the power cord must be at least 1.5 m (5.00 ft) and a maximum of 2.0 m (6.50 ft).
- All power cords must be approved by an acceptable accredited agency responsible for evaluation in the country where the power cord will be used.
- The power cord must have a minimum current capacity of 10 amps and a nominal voltage rating of 125 or 250 V AC, as required by each country's power system.
- The appliance coupler must meet the mechanical configuration of an EN 60 320/IEC 320 Standard Sheet C13 connector for mating with the appliance inlet on the back of the notebook.

Country-Specific Requirements

3-Conductor Power Cord Requirements		
Country	Accredited Agency	Applicable Note Number
Australia	EANSW	1
Austria	OVE	1
Belgium	CEBC	1
Canada	CSA	2
Denmark	DEMKO	1
inland	FIMKO	1
rance	UTE	1
Germany	VDE	1
taly	IMQ	1
Japan	METI	3
The Netherlands	KEMA	1
Norway	NEMKO	1
Sweden	SEMKO	1
Switzerland	SEV	1

3-Conductor Power Cord Requirements (Continued)

Country	Accredited Agency	Applicable Note Number
United Kingdom	BSI	1
United States	UL	2

Notes

- The flexible cord must be <HAR> Type HO5VV-F, 3-conductor, 1.0 mm² conductor size. Power cord fittings (appliance coupler and wall plug) must bear the certification mark of the agency responsible for evaluation in the country where it will be used.
- The flexible cord must be Type SPT-3 or equivalent, No. 18 AWG, 3-conductor. The wall plug must be a two-pole grounding type with a NEMA 5-15P (15 A, 125 V) or NEMA 6-15P (15 A, 250 V) configuration.
- 3. The appliance coupler, flexible cord, and wall plug must bear a "T" mark and registration number in accordance with the Japanese Dentori Law. The flexible cord must be Type VCT or VCTF, 3-conductor, 1.00 mm² conductor size. The wall plug must be a two-pole grounding type with a Japanese Industrial Standard C8303 (7 A, 125 V) configuration.

Screw Listing

This appendix provides specification and reference information for the screws used in the notebook. All screws listed in this appendix are available in the Miscellaneous Screw Kit, spare part number 345057-001.

Table C-1 Torx T5M2.5×4.0 Screw

Color	Qty.	Length	Thread	Head Width
Silver	2	4.0 mm	2.5 mm	5.0 mm

Where used:

Two screws that secure the hard drive to the hard drive frame (documented in Section 5.3)

Table C-2 Phillips PM3.0×3.5 Screw

Color	Qty.	Length	Thread	Head Width
Silver	2	3.5 mm	3.0 mm	4.5 mm

Where used:

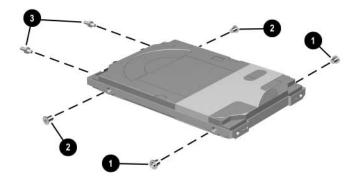
2 Two screws that secure the hard drive to the hard drive frame (documented in Section 5.3)

Table C-3 M2.0×10.0 Alignment Pin

	Color	Qty.	Length	Thread	Head Width
	Silver	2	10.0 mm	2.0 mm	4.0 mm

Where used:

Two alignment pins that secure the hard drive to the hard drive frame (documented in Section 5.3)



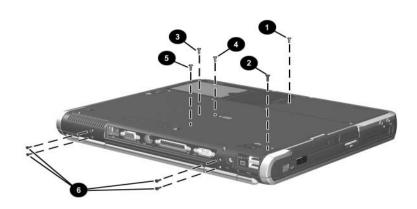
Torx T5M2.5 \times 4.0 Screw, Phillips PM3.0 \times 3.5 Screw, and M2.0 \times 10.0 Alignment Pin Locations

Table C-4 Torx T8M2.0×6.0 Screw

######################################	Color	Qty.	Length	Thread	Head Width
	Black	27	6.0 mm	2.0 mm	5.0 mm

Where used:

- One screw that secures the hard drive cover to the notebook (documented in Section 5.3)
- One screw that secures the Bluetooth cover to the notebook (documented in Section 5.6)
- One screw that secures the optical drive to the notebook (documented in Section 5.8)
- One screw that secures the keyboard to the notebook (documented in Section 5.9)
- One screw that secures the LED switch cover to the notebook (documented in Section 5.15)
- 6 Four screws that secure the display assembly and hinge covers to the notebook (documented in Section 5.18)



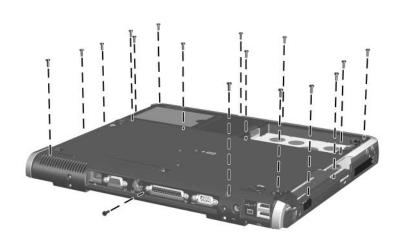
Torx T8M2.0×6.0 Screw Locations

Table C-4 Torx T8M2.0×6.0 Screw (Continued)

Color	Qty.	Length	Thread	Head Width
Black	27	6.0 mm	2.0 mm	5.0 mm

Where used:

Seventeen screws that secure the top cover to the notebook (documented in Section 5.19)



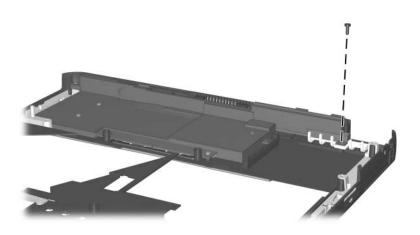
Torx T8M2.0×6.0 Screw Locations

Table C-4 Torx T8M2.0×6.0 Screw (Continued)

######################################	Color	Qty.	Length	Thread	Head Width
	Black	27	6.0 mm	2.0 mm	5.0 mm

Where used:

One screw that secures the speaker to the top cover (documented in Section 5.20)



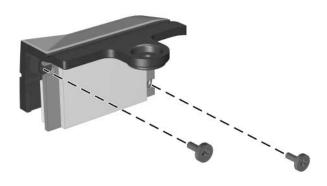
Torx T8M2.0×6.0 Screw Location

	Table C-5	
Phillips	PM1.5×3.0	Screw

≣ ≣⊕ □ mm!!!!!!!!!!!!!!	Color	Qty.	Length	Thread	Head Width
	Black	3	3.0 mm	1.5 mm	3.0 mm

Where used:

Two screws that secure the Bluetooth board to the Bluetooth cover (documented in Section 5.6)



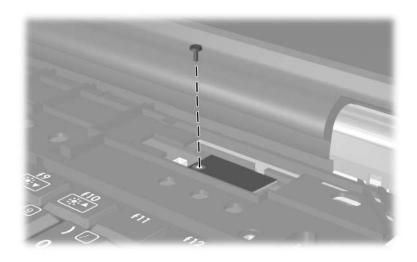
Phillips PM1.5×3.0 Screw Locations

Table C-6 Phillips PM3.5×3.0 Screw

≣ ≣⊕ □ mm!!!!!!!!!!!!!!	Color	Qty.	Length	Thread	Head Width
	Black	3	3.0 mm	1.5 mm	3.5 mm

Where used:

One screw that secures the security card to the system board (documented in Section 5.17)



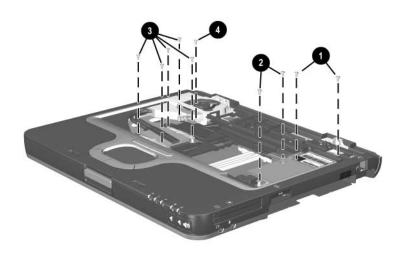
Phillips PM3.5×3.0 Screw Location

Table C-7 Torx T8M2.0×4.0 Screw

######################################	Color	Qty.	Length	Thread	Head Width
	Pewter	20	4.0 mm	2.0 mm	5.0 mm

Where used:

- Two screws that secure the modem board to the system board (documented in Section 5.11)
- 2 Two screws that secure the Mini PCI communications board and shield to the system board (documented in Section 5.12)
- Five screws that secure the heat sink to the system board (documented in Section 5.13)
- One screw that secures the top cover to the notebook (documented in Section 5.19)



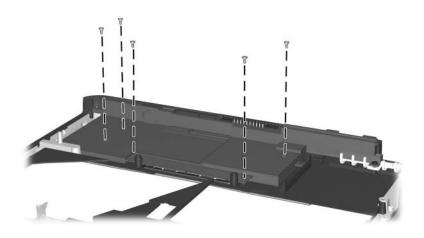
Torx T8M2.0×4.0 Screw Locations

Table C-7 Torx T8M2.0×4.0 Screw (Continued)

######################################	Color	Qty.	Length	Thread	Head Width
	Pewter	20	4.0 mm	2.0 mm	5.0 mm

Where used:

Five screws that secure the speaker to the top cover (documented in Section 5.20)



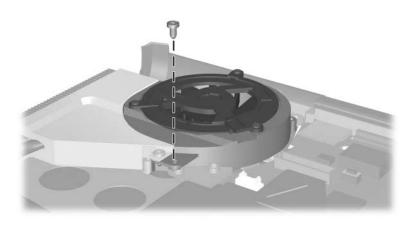
Torx T8M2.0×4.0 Screw Locations

Table C-7 Torx T8M2.0×4.0 Screw (Continued)

Color	Qty.	Length	Thread	Head Width
Pewter	20	4.0 mm	2.0 mm	5.0 mm

Where used:

One screw that secures the fan assembly to the notebook (documented in Section 5.22)



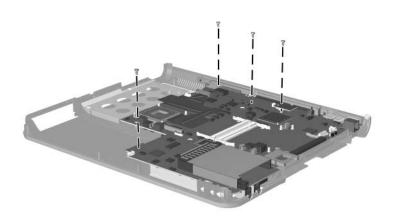
Torx T8M2.0×4.0 Screw Location

Table C-7 Torx T8M2.0×4.0 Screw (Continued)

Color	Qty.	Length	Thread	Head Width
Pewter	20	4.0 mm	2.0 mm	5.0 mm

Where used:

Four screws that secure the system board to the notebook (documented in Section 5.23)



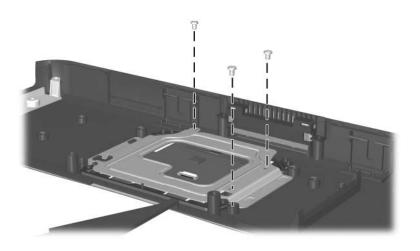
Torx T8M2.0×4.0 Screw Locations

Table C-8 Torx T8M2.0×3.5 Screw

Color	Qty.	Length	Thread	Head Width
Silver	3	3.5 mm	2.0 mm	5.0 mm

Where used:

Three screws that secure the TouchPad and bracket to the top cover (documented in Section 5.21)



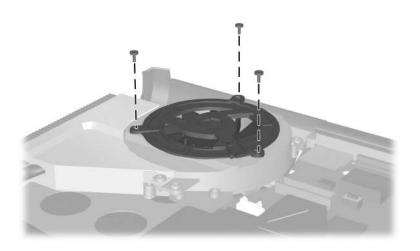
Torx T8M2.0×3.5 Screw Locations

Table C-9 Phillips PM1.5×4.0 Screw

≣ ≣⊕ === mm:::::::::::::::::::::::::::::::::	Color	Qty.	Length	Thread	Head Width
	Black	3	4.0 mm	1.5 mm	3.0 mm

Where used:

Three screws that secure the fan to the fan housing (documented in Section 5.22)



Phillips PM1.5×4.0 Screw Locations

Index

1394 connector 1–21 A AC adapter	Bluetooth cable illustrated 3–10 removal 5–14
spare part number 3–13, 3–14 specifications 6–7 application key 1–24	Bluetooth compartment 1–30 Bluetooth cover removal 5–13 bottom components 1–29
audio line-out jack location 1–19 pin assignments A–4	cables, service considerations 4–2 caps lock key 1–24
pin assignments A–4 audio troubleshooting 2–25 B base enclosure, spare part number 3–7 battery bay 1–22, 1–30 battery bezel removal 5–7 battery light 1–28 battery pack release latch 1–30 removal 5–6 spare part number 3–7, 5–6 specifications 6–7	caps lock key 1–24 caps lock light 1–26 carrying case, spare part numbers 3–13 CD-ROM Drive illustrated 3–11 spare part number 3–7, 3–12 specifications 6–11 components bottom 1–29 front 1–18 keyboard 1–23
Bluetooth board removal 5–13 spare part number 3–7, 5–13	left-side 1–20 rear 1–20 right-side 1–18 top 1–25, 1–27

Computer Setup	diskette drive
Advanced Menu 2–5	OS loading problems 2–23
File Menu 2–3	spare part number 3–7,
overview 2–2	5–12
Security Menu 2-4	display assembly
connector pin assignments	illustrated 3–2
audio line-out jack A-4	removal 5–35
external monitor connector	spare part numbers 3–3,
A-3	5–35
microphone jack A-4	specifications 6–3, 6–4,
modem jack A-2	6–5
monitor connector A-3	display lid switch 1-26
network jack A-1	display release latch 1–19
parallel connector A-5	DMA specifications 6–12
RJ-11 telephone jack A-2	docking connector 1–30
RJ-45 network jack A-1	drive light 1–28
serial connector A-6	drives, preventing damage 4–3
S-Video connector A-3	DVD+RW/R and CD-RW
Universal Serial Bus (USB)	Combo Drive
connector A-2	illustrated 3–11
connectors, service	spare part number 3–7,
considerations 4–2	3–12
cursor control keys 1–24	specifications 6–8
D	DVD/CD-RW Combo Drive
design overview 1–31	illustrated 3–11
diagnostics	spare part number 3–7,
configuration information	3–12
2–7	specifications 6–9
test information 2–8	DVD-ROM Drive
Diagnostics for Windows 2–2,	illustrated 3–11
2–7	spare part number 3–7,
disassembly sequence chart	3–12
5–3	specifications 6–10

E	heat sink
electrostatic discharge 4–4,	removal 5–27
4–8	spare part number 3–5,
external monitor connector	5–27
location 1–22	hinge cover removal 5-37
pin assignments A-3	1
F	I/O address specifications
f1 through f12 function keys	6–14
1–24	infrared port 1–19
fan assembly	integrated smart card
illustrated 3–4, 3–6	removal 5–15
removal 5-44	spare part number 3–5,
spare part number 3–5,	5–15
5–44	internal keypad 1–24
features 1–13	interrupt specifications 6–13
feet, locations 5–11	K
fn key 1–24	keyboard
front components 1–18	components 1–23
G	illustrated 3–2
grounding equipment and	removal 5–18
methods 4–7	spare part numbers 3–3,
	5–18
H	troubleshooting 2–28
hard drive	L
connector 5–10	-
cover latch 1–30	LED switch cover illustrated 3–2
disassembly 5–10	removal 5–31
illustrated 3–11 location 1–30	
	spare part number 3–3, 3–17, 5–31
OS loading problems 2–20 removal 5–8	left-side components 1–20
	light 1–28
spare part numbers 3–7, 3–11, 5–8	ngm 1–20
specifications 6–6	
hard drive cover removal 5–8	

P	rear components 1–20
packing precautions 4–5	release latch 1–30
parallel connector	removal
location 1–22	preliminaries 4–1
pin assignments A-5	procedures 5–1
password, clearing 1–16	replacement
PC Card eject buttons 1–19	preliminaries 4–1
PC Card slots 1–19	procedures 5–1
plastic parts 4–2	right-side components 1–18
pointing device,	RJ-11 telephone jack
troubleshooting 2–29	location 1–19
pointing stick 1–26	pin assignments A–2
pointing stick buttons 1–28	RJ-45 network jack
port replicator	location 1–22
spare part numbers 3–13	pin assignments A-1
troubleshooting 2–18	S
power button 1–26	Screw Kit
power connector 1–22	contents 3–13
power cord, spare part	spare part number 3–13,
numbers 3–13	3–16
power management features	scroll lock light 1–26
1–17	Secure Digital (SD) slot 1–19
power, troubleshooting 2–12	security cable slot 1–22
power/Standby light 1–28	security card, illustrated 3–4,
processor	3–6
illustrated 3–4, 3–6	security module
removal 5–29	removal 5–34
spare part numbers 3–5,	spare part number 3–5,
5–29	3–17, 5–34
Q	serial connector
Quick Launch buttons 1–26	location 1–22
	pin assignments A–6
R	serial number 1–30, 3–1, 5–2
real time clock battery	service considerations 4–2
illustrated 3–9	
removal 5–33	

smart card	top cover
removal 5–15	illustrated 3–2
spare part number 3–5,	removal 5–38
5–15	spare part number 3–3,
speaker, removal 5-41	5–38
specifications	TouchPad
AC adapter 6–7	buttons 1–28
battery pack 6–7	location 1–28
CD-ROM Drive 6–11	removal 5–42
display 6–3, 6–4, 6–5	TPM
DMA 6-12	removal 5–34
DVD+RW/R and CD-RW	spare part number 3–5,
Combo Drive 6–8	3–17, 5–34
DVD/CD-RW Combo	transporting precautions 4–5
Drive 6–9	troubleshooting
DVD-ROM Drive 6–10	audio 2–25
hard drive 6–6	Computer Setup 2–2
I/O addresses 6–14	Diagnostics for Windows
interrupts 6–13	2–7
notebook 6-1	flowcharts 2–10
static shielding materials 4–8	keyboard 2–28
stereo speakers 1–19	modem 2–30
S-Video connector	network 2–30
location 1–22	nonfunctioning device
pin assignments A–3	2–18, 2–27
system board	operating system loading
illustrated 3–4, 3–6	2–19
removal 5–46	overview 2–1
spare part numbers 3–5,	pointing device 2–29
5–46	port replicator 2–18
Т	power 2–12
tools required 4–1	video 2–16
top components 1–25, 1–27	
top components 1–23, 1–27	

U

Universal Serial Bus (USB) connector location 1–21 pin assignments A–2

V

vent 1–22, 1–26 video troubleshooting 2–16 volume control buttons 1–19

W

Windows logo key, location 1–24 wireless LAN, spare part numbers 3–7 wireless on/off light 1–28